

High Side Line Switch with Low Supply Current

GENERAL DESCRIPTION

The XC8101 series is a low supply current line switch IC with ON/OFF control and output current protection which integrates P-channel MOSFET. The XC8101 is suited for power distribution switch. With connecting to the output pin of step-down DC/DC converters, the CE pin controls ON/OFF for each distribution switch to deliver power per requirements and maximize total power efficiency. As result, the XC8101 helps extend battery life and product operation time. The XC8101 is available in an ultra small package USP-4 and does not require any external capacitors so that it can provide small power unit design and board space saving. When low signal is input to the CE pin, the XC8101 enters stand-by mode. Even where a load capacitor is connected to the output pin during in the stand-by mode, the internal switch between the V_{OUT} and V_{SS} of the XC8101 enables the electric charge in the load capacitor to be discharged. Because of this discharge function, the V_{OUT} pin voltage falls quickly to V_{SS} level.

The XC8101 contains an over current protection with foldback current circuitry which operates as over current protection and short circuit protection for the output pin.

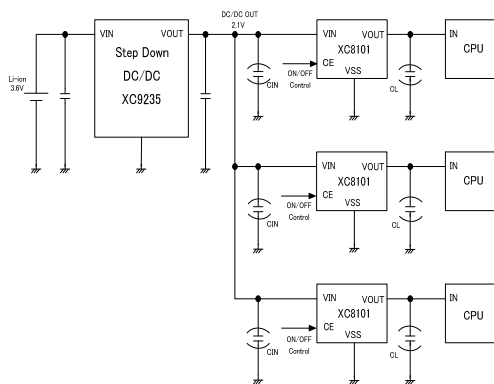
APPLICATIONS

- Mobile phones, Smart phones
- Digital still cameras, Digital video cameras
- Portable games
- Portable equipment

FEATURES

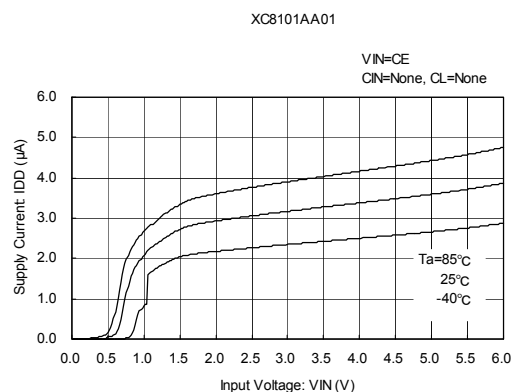
- On Resistance : 0.75Ω@ $V_{IN}=2.9V$ (TYP.)
: 1.15Ω@ $V_{IN}=1.8V$ (TYP.)
- Output Current : 200mA
<Current Limit = 300mA (TYP.)>
- Input Voltage Range : 1.8V ~ 6.0V
- Power Consumption : 3.0 μA@ $V_{IN}=1.8V$
- Stand-by Current : 0.1 μA
- Protection Circuit : Current limit, 300mA (TYP.)
: Short-circuit Protection,
Short current= 30mA (TYP.)
- ON/OFF Function : High Active Enable
- High-Speed Discharge Function
- Operating Temperature Range : -40 ~ 85
- Packages : USP-4, SSOT-24, SOT-25

TYPICAL APPLICATION CIRCUIT

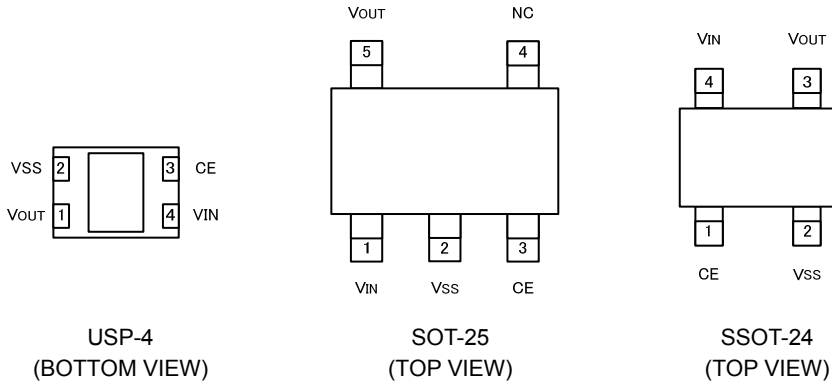


TYPICAL PERFORMANCE CHARACTERISTICS

Supply Current vs. Input Voltage



PIN CONFIGURATION



*The heat dissipation pad of the USP-4 package is recommended to solder as shown in the recommended mount pattern and metal mask pattern for mounting strength. The heat dissipation pad should be electrically opened or connected to the V_{SS} (No. 2) pin.

PIN ASSIGNMENT

PIN NUMBER			PIN NAME	FUNCTIONS
USP-4	SOT-25	SSOT-24		
4	1	4	V_{IN}	Power Input
1	5	3	V_{OUT}	Output
2	2	2	V_{SS}	Ground
3	3	1	CE	ON/OFF Control
-	4	-	NC	No Connection

PRODUCT CLASSIFICATION

Ordering Information

XC8101

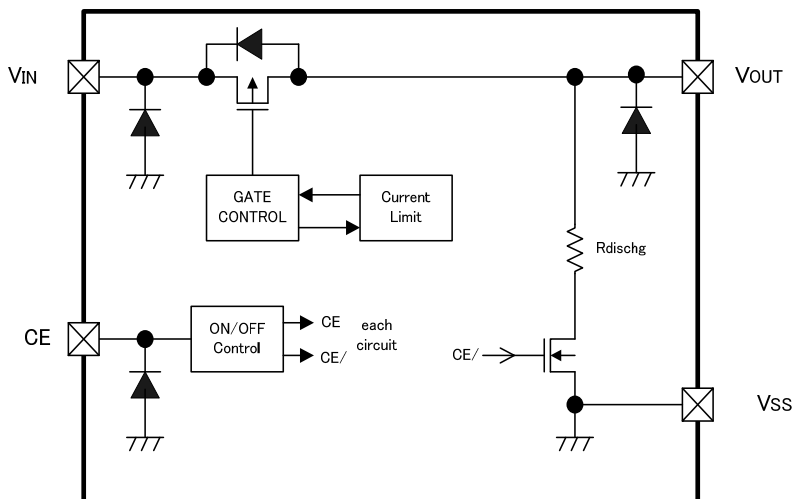
DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
	CE pin logic	A	: High active enable
	C_L Discharge Function	A	: Output capacitor (C_L) auto-discharge function integrated
	Internal Standard Number	01	: Fixed
	Packages	G	: USP-4
		M	: SOT-25
		N	: SSOT-24
	Device Orientation	R	: Embossed tape, standard feed
		L	: Embossed tape, reverse feed

FUNCTION CHART

SERIES	CE	IC OPERATIONAL STATUS ON/OFF
XC8101AA01	High	ON
	Low	OFF

BLOCK DIAGRAM

XC8101AA Series



* Diodes inside the circuit are an ESD protection diode and a parasitic diode.

ABSOLUTE MAXIMUM RATINGS

Ta=25

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V_{IN}	$V_{SS}-0.3 \sim +6.5$	V
Output Current	I_{OUT}	450 *	mA
Output Voltage	V_{OUT}	$V_{SS}-0.3 \sim V_{IN}$	V
CE Input Voltage	V_{CE}	$V_{SS}-0.3 \sim +6.5$	V
Power Dissipation	USP-4	120	mW
	SOT-25	150	
	SSOT-24	250	
Operating Temperature Range	Topr	-40 ~ +85	°C
Storage Temperature Range	Tstg	-55 ~ +125	°C

* Please make sure that I_{OUT} is less than $P_d/(V_{IN}-V_{OUT})$.

ELECTRICAL CHARACTERISTICS

XC8101AA Series

Ta=25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Input Voltage	V _{IN}		1.8	-	6.0	V	-
On Resistance (SSOT-24 / USP-4)	R _{ON}	V _{IN} =6.0V, V _{CE} =V _{IN}	-	0.55	0.90		
		V _{IN} =4.0V, V _{CE} =V _{IN}	-	0.65	1.00		
		V _{IN} =2.9V, V _{CE} =V _{IN}	-	0.75	1.10		
		V _{IN} =1.8V, V _{CE} =V _{IN}	-	1.15	1.50		
On Resistance (SOT-25)	R _{ON}	V _{IN} =6.0V, V _{CE} =V _{IN}	-	0.65	1.00		
		V _{IN} =4.0V, V _{CE} =V _{IN}	-	0.75	1.10		
		V _{IN} =2.9V, V _{CE} =V _{IN}	-	0.85	1.20		
		V _{IN} =1.8V, V _{CE} =V _{IN}	-	1.25	1.60		
Supply Current	I _{DD}	V _{IN} =6.0V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	2.7	8.2	μA	
		V _{IN} =4.0V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	2.3	7.3		
		V _{IN} =2.9V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	2.2	6.9		
		V _{IN} =1.8V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	2.0	6.2		
Stand-by Current	I _{STBY}	V _{IN} =6.0V, V _{CE} =V _{SS} , V _{OUT} =OPEN	-	0.01	0.10	μA	
Switch Leakage Current	I _{LEAK}	V _{IN} =6.0V, V _{CE} =V _{OUT} =V _{SS}	-	0.01	0.10	μA	
Current Limit	I _{LIM}	V _{CE} =V _{IN} , V _{OUT} =V _{IN} -1.0V	200	300	-	mA	
Short Circuit Current	I _{SHORT}	V _{CE} =V _{IN} , V _{OUT} =0V	-	30	-	mA	
CE High Level Voltage	V _{CEH}		1.2	-	6.0	V	
CE Low Level Voltage	V _{CEL}		-	-	0.3	V	
CE High Level Current	I _{CEH}	V _{CE} =V _{IN}	-0.1	-	0.1	μA	
CE Low Level Current	I _{CEL}	V _{CE} =V _{SS}	-0.1	-	0.1	μA	
C _L Auto-Discharge Resistance	R _{DCHG}	V _{IN} =4.0V, V _{OUT} =4.0V, V _{CE} =V _{SS}	650	900	1100		
Turn On Time ^(*1)	t _{DLY(ON)}	V _{IN} =4.0V, V _{CE} =0.3V-1.2V, R _L =80Ω, without C _{IN} , C _L	-	6	13	μs	
Turn Off Time ^(*2)	t _{DLY(OFF)}	V _{IN} =4.0V, V _{CE} =1.2V-0.3V, R _L =80Ω, without C _{IN} , C _L	-	2.0	4.0	μs	

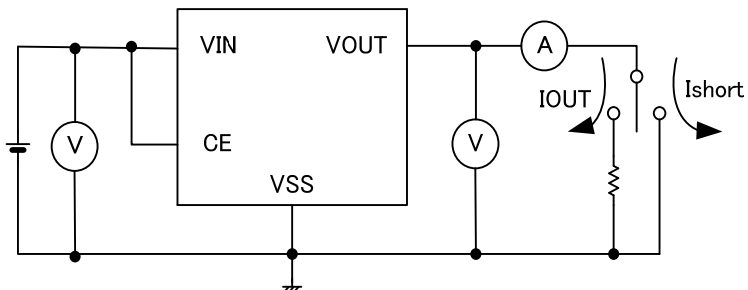
NOTE:

*1: Time to reach 90% of V_{OUT} after V_{CE} entering the V_{CEH} threshold.

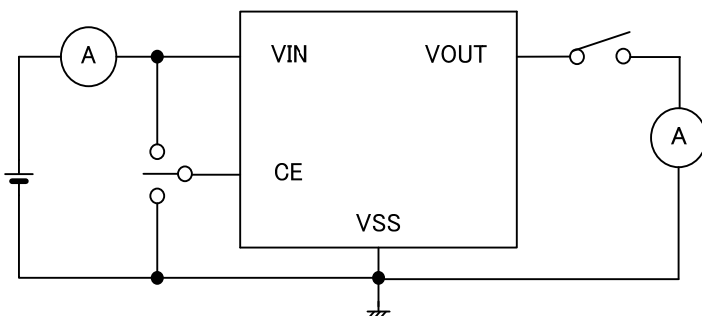
*2: Time to fall to 10% of V_{OUT} after V_{CE} entering the V_{CEL} threshold.

TEST CIRCUITS

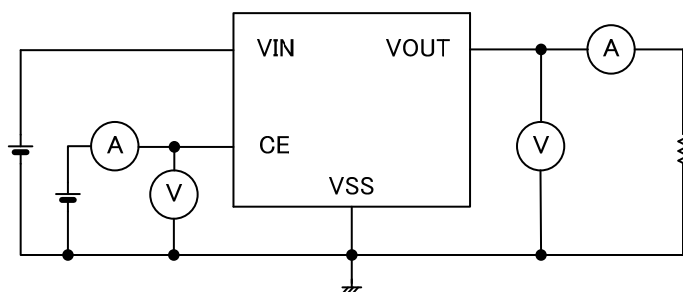
Circuit



Circuit

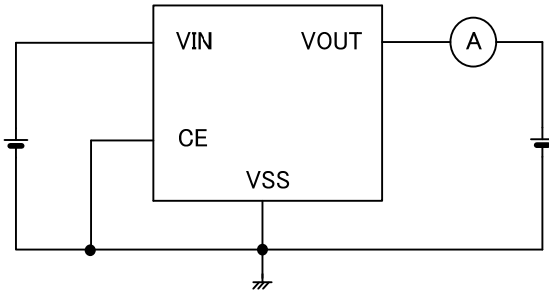


Circuit

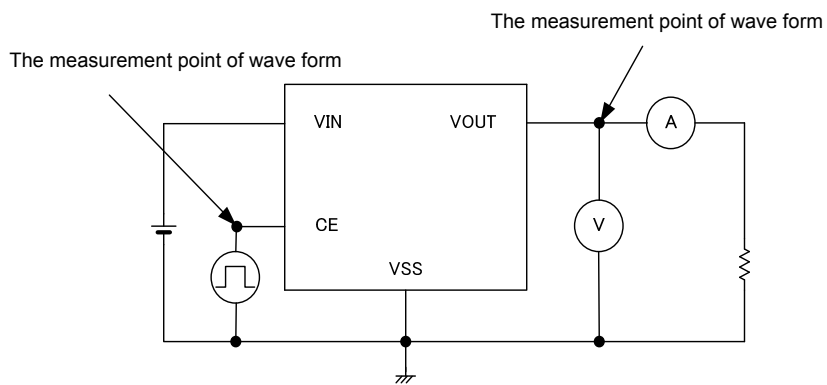


TEST CIRCUITS (Continued)

Circuit



Circuit



OPERATIONAL EXPLANATION

<CE Pin>

The XC8101 enables an output P-channel MOSFET switch and the IC internal circuitry to turn off by the signal to the CE pin. In the shutdown mode, the V_{OUT} pin will be pulled down to the V_{SS} by the C_L auto-discharge function.

The output voltage becomes unstable when the CE pin is opened. If the input voltage to the CE pin is within the specified threshold voltages, the logic is fixed and the XC8101 will operate normally. However, supply current may increase as a result of the shoot-through current of internal circuitry when the medium level voltage is input to the CE pin.

<Input Capacitor>

The XC8101 works well without an output capacitor (C_L). However, an output capacitor such as a bypass capacitor is tied up to the output side of the IC, input voltage ringing may occur when the IC is turned on. In order to reduce the ringing, an input capacitor with the value of $1\ \mu\text{F}$ or more is requested to attach between V_{IN} pin and V_{SS} pin. The capacitor should be tied and placed as close as the IC.

<CL Auto-Discharge Function>

The XC8101A contains a C_L auto-discharge resistor and an N-channel transistor between the V_{OUT} pin and the V_{SS} pin. The XC8101A quickly discharge the electric charge in the output capacitor (C_L) when a low signal to the CE pin is input to turn off a whole IC circuit. The C_L auto-discharge resistance is set at $900\ \Omega$ ($V_{OUT}=4.0\text{V TYP. @ } V_{IN}=4.0$). Discharge time of the output capacitor (C_L) is determined by a C_L auto-discharge resistor value (R_{DCHG}) and an output capacitor value. Time constant τ is defined as ($\tau = C \times R_{DCHG}$). Output voltage after starting discharge can be calculated by the following formula.

$$V = V_{OUT} \times e^{-t/\tau}, \text{ or } t = \tau \times \ln(V_{OUT} / V)$$

V: Output voltage after starting discharge

V_{OUT} : Output voltage

t: Discharge time

τ : Output discharge resistor value R_{dischg} \times Output capacitor (C_L) value C

<Current Limiter, Short-Circuit Protection>

The XC8101 series contains a constant current limiter and foldback current circuitry. The constant current limiter operates to limit output current and the foldback current circuitry operates as short circuit protection for the output pin.

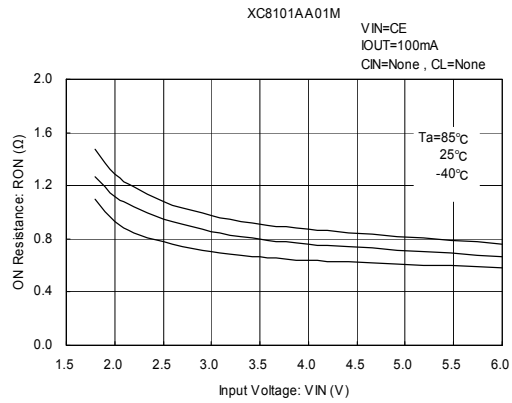
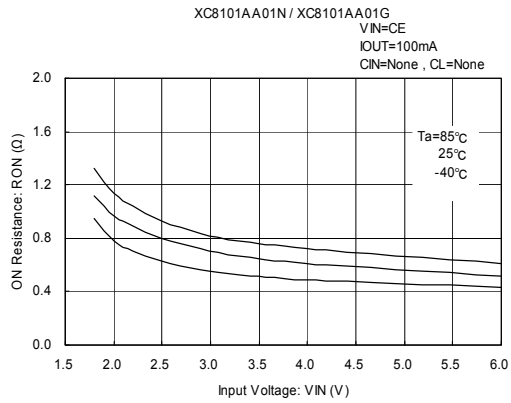
When the load current reaches the limit current, the constant current limiter operates and the output voltage drops. The output voltage further, then the foldback current circuitry operates to decrease the output current. When the output pin is short-circuited to the ground, the output current drops and maintains a flow about 30mA.

NOTES ON USE

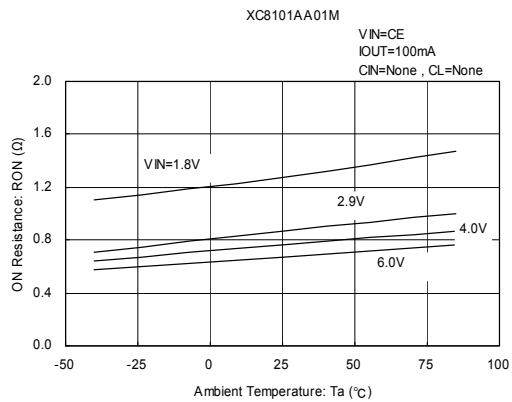
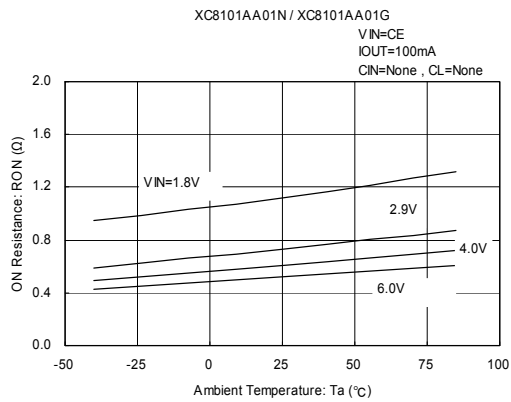
1. Please use this IC within the stated absolute maximum ratings. Operation beyond these limits may cause degrading or permanent damage to the device.
2. The X8101 goes into an undefined operation when the CE pin is left open. The CE pin shall be tied to low or high level.
3. V_{OUT} pin voltage should not be applied beyond the V_{IN} pin voltage. The IC may get damage due to the reverse current toward the V_{IN} pin.

TYPICAL PERFORMANCE CHARACTERISTICS

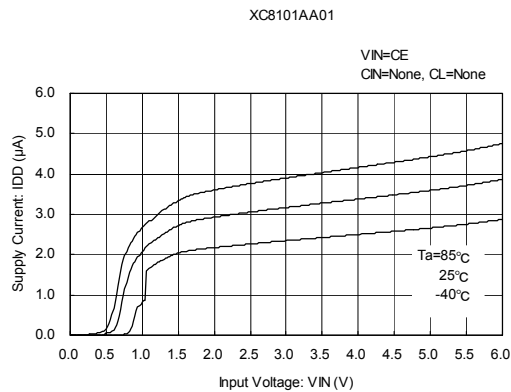
(1) ON Resistance vs. Input Voltage



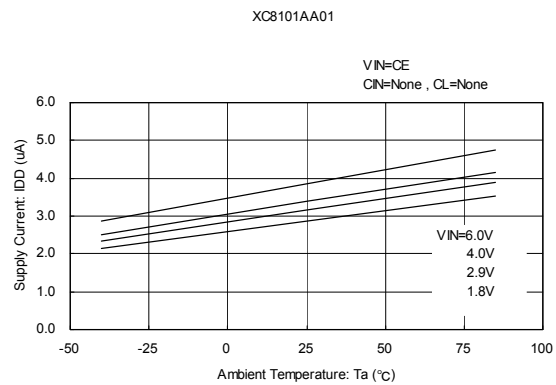
(2) ON Resistance vs. Ambient Temperature



(3) Supply Current vs. Input Voltage

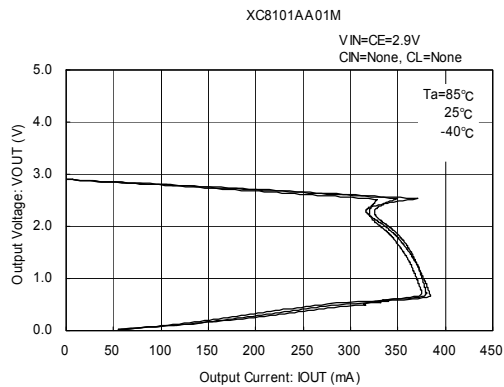
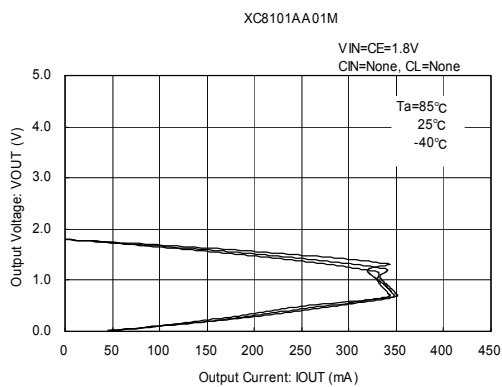
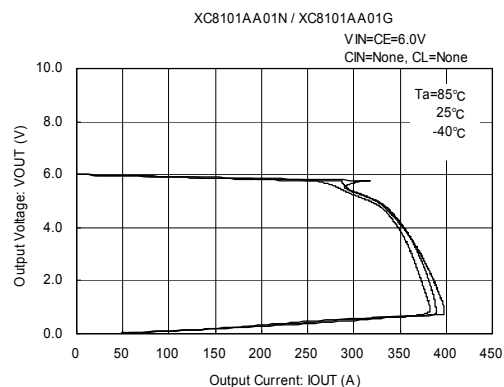
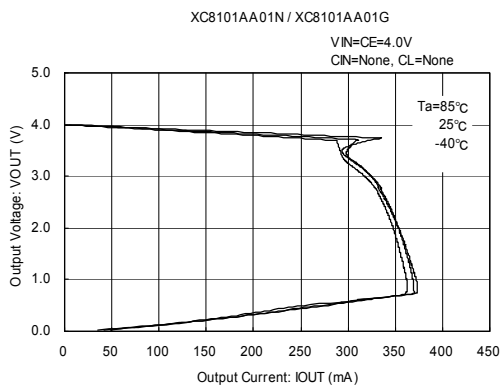
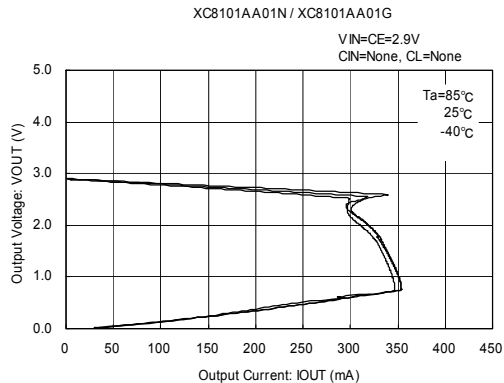
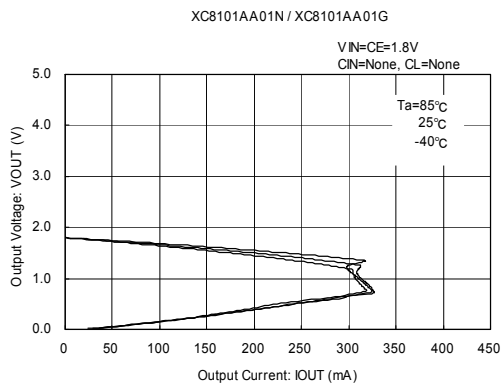


(4) Supply Current vs. Ambient Temperature



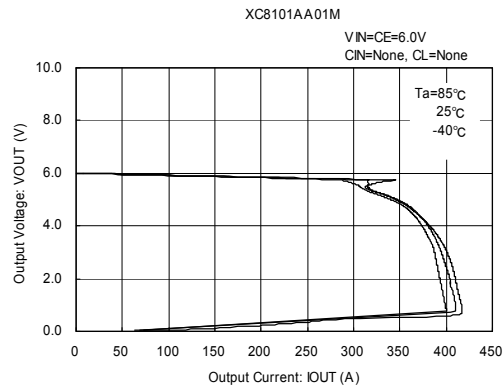
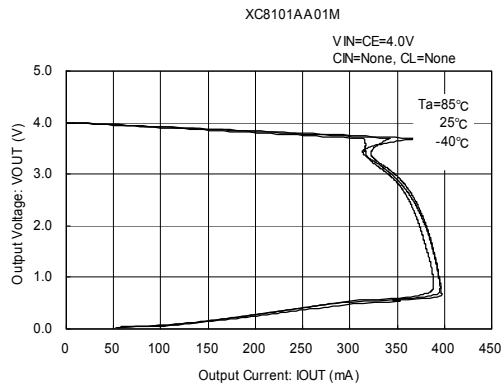
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Output Current

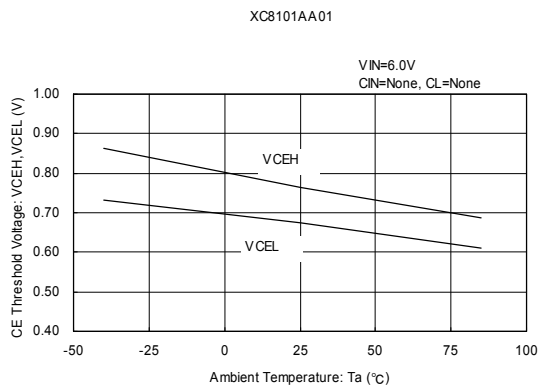


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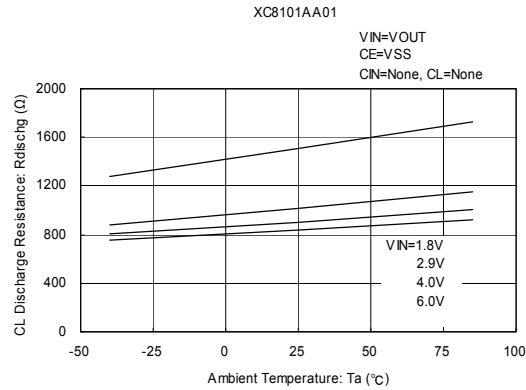
(5) Output Voltage vs. Output Current (Continued)



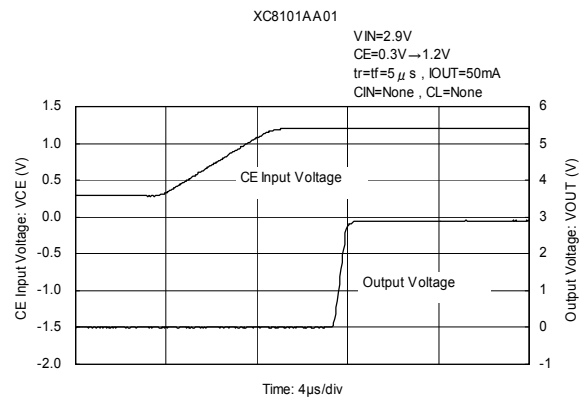
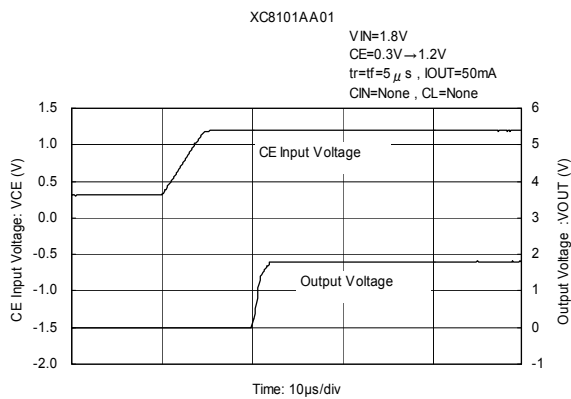
(6) CE Threshold Voltage vs. Ambient Temperature



(7) CL Discharge Resistance vs. Ambient Temperature

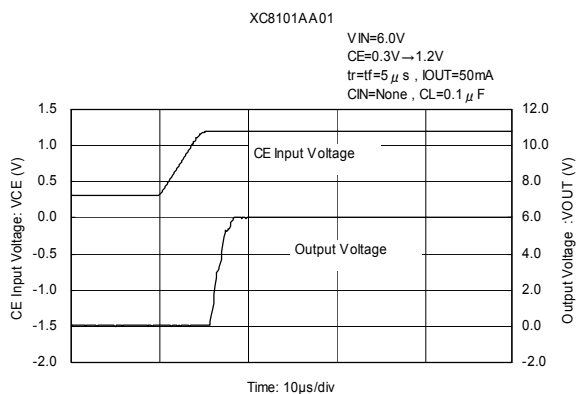
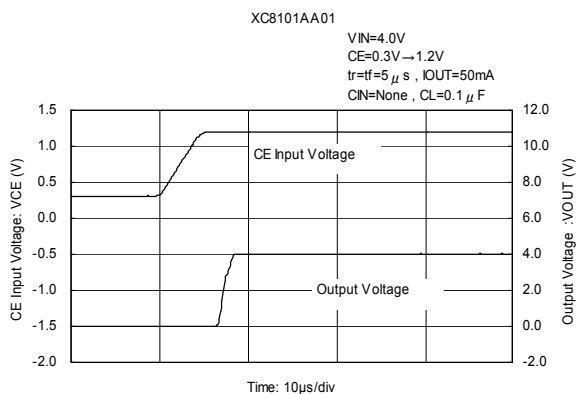
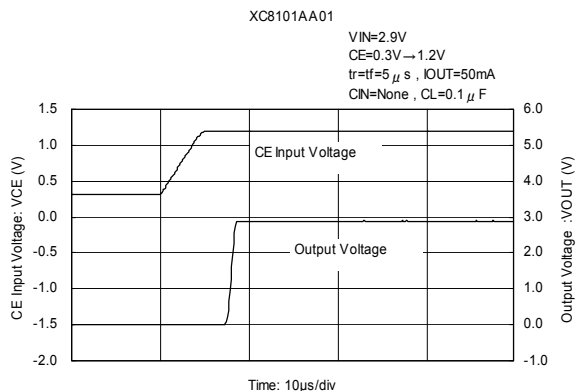
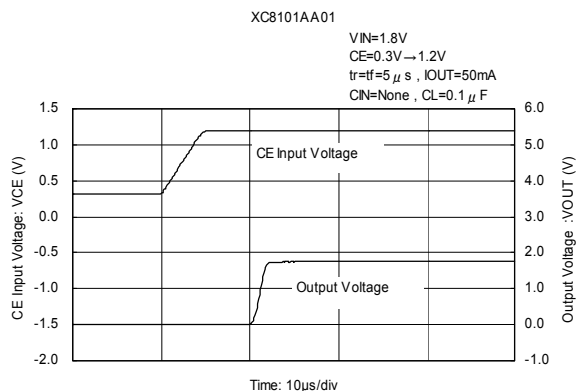
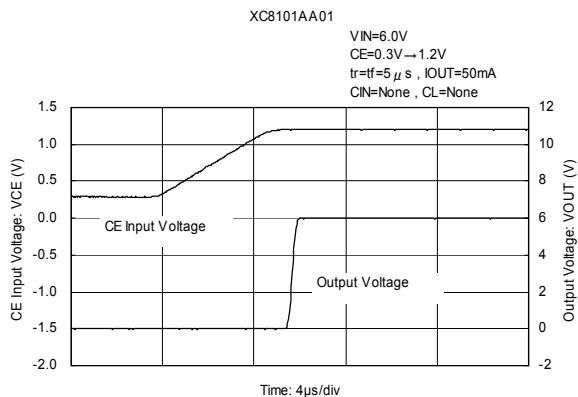
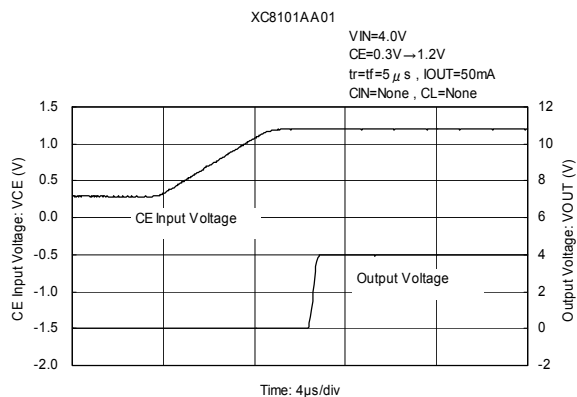


(8) Output Turn-on Time with CE



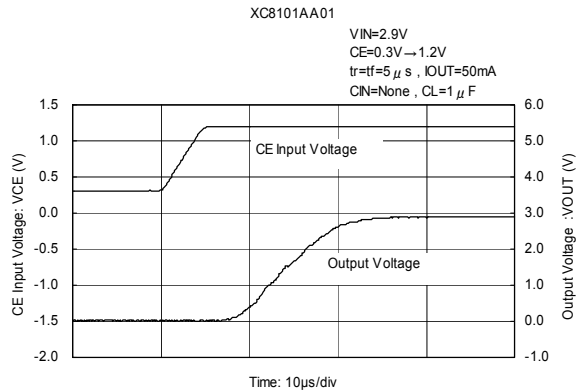
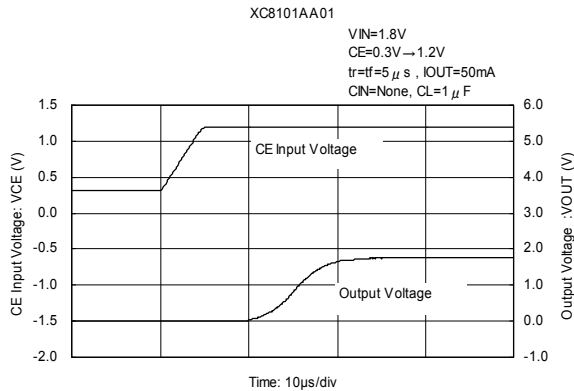
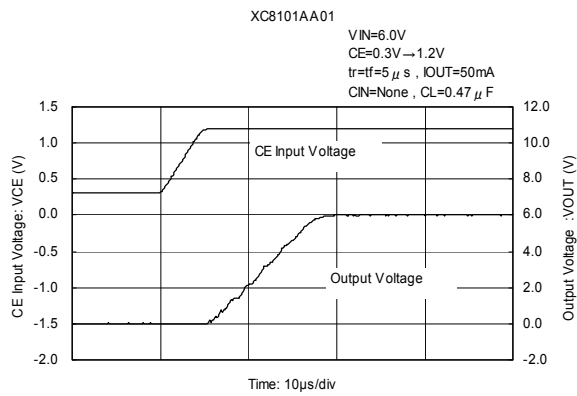
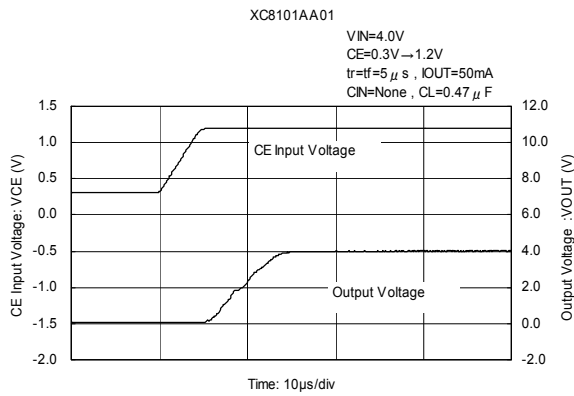
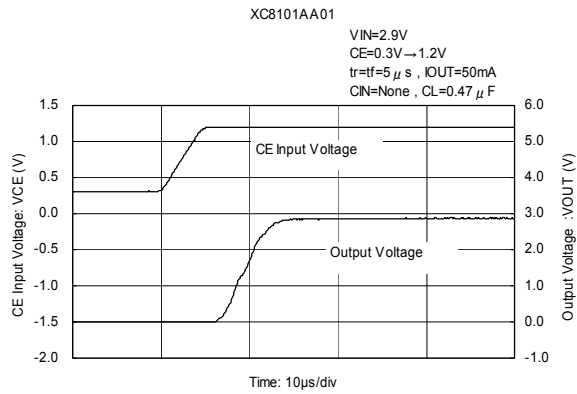
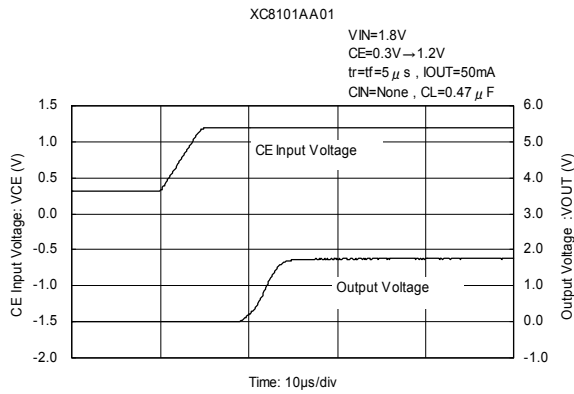
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



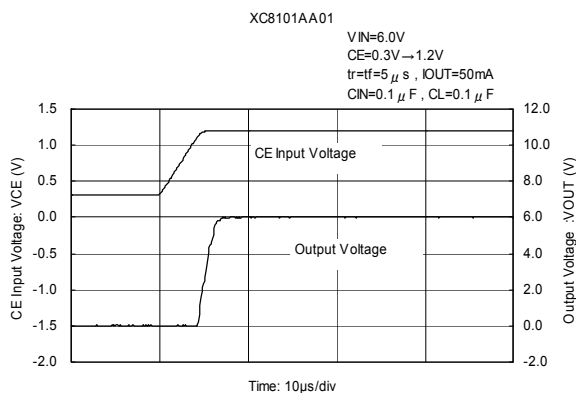
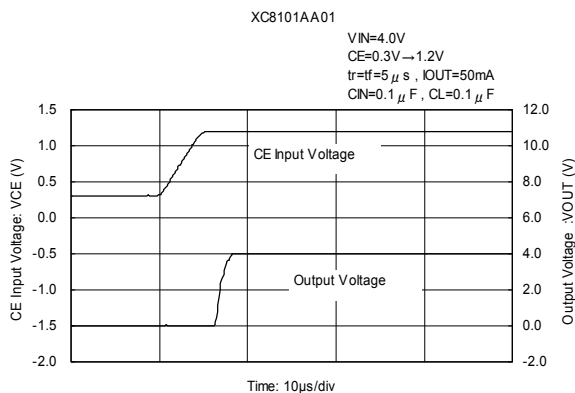
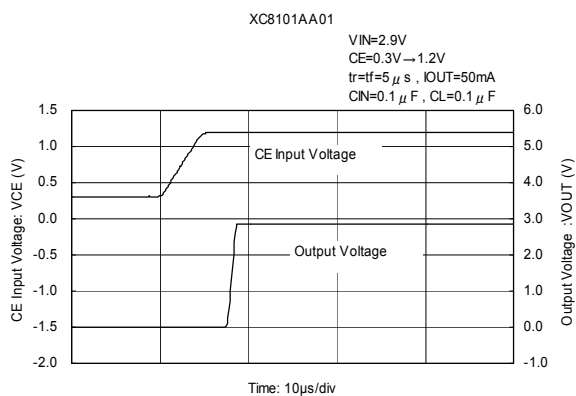
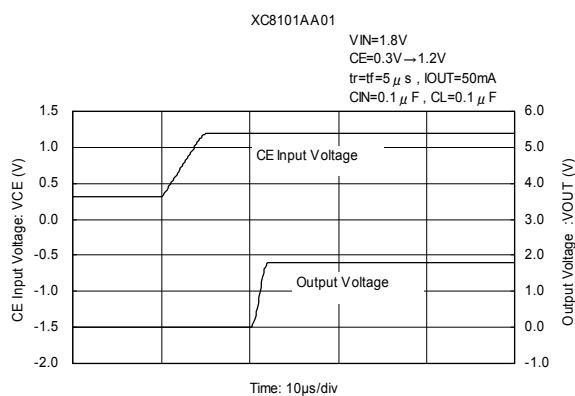
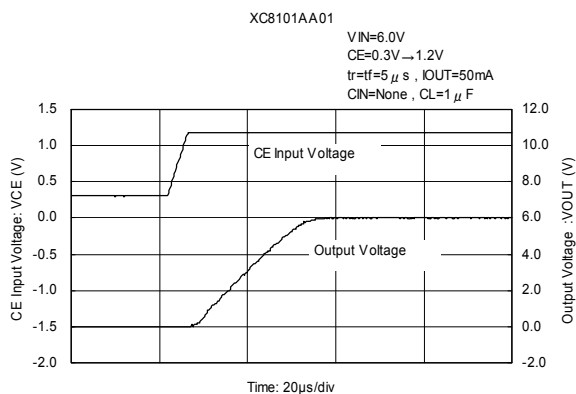
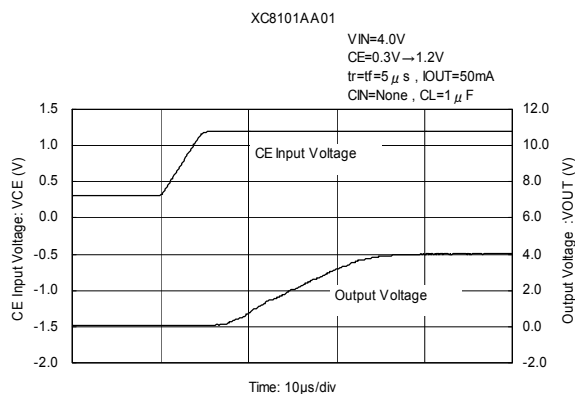
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



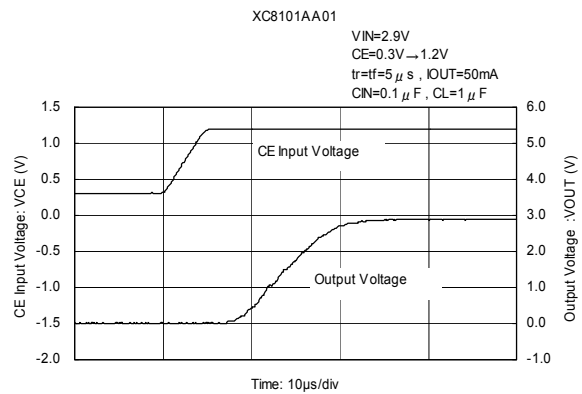
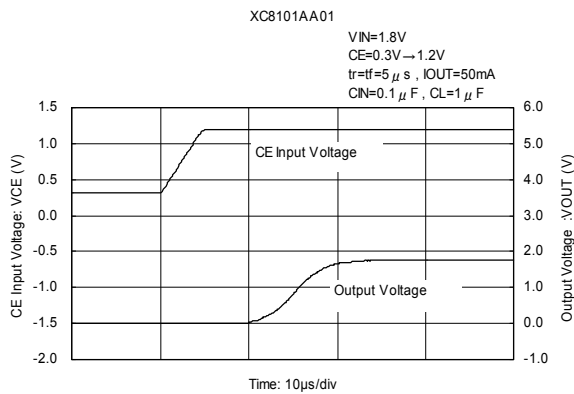
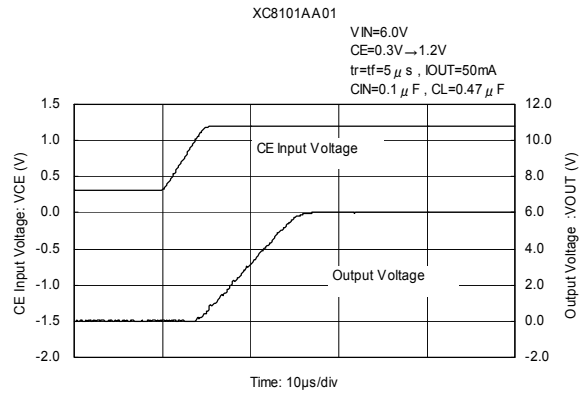
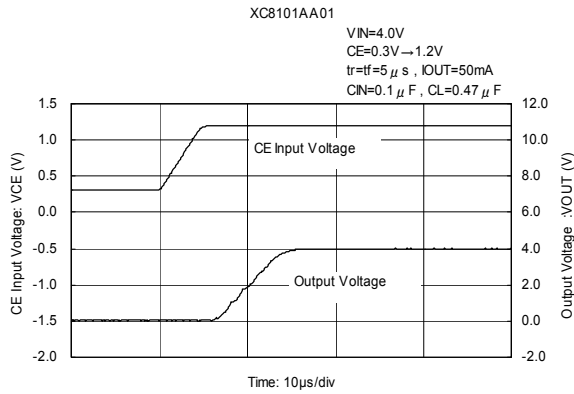
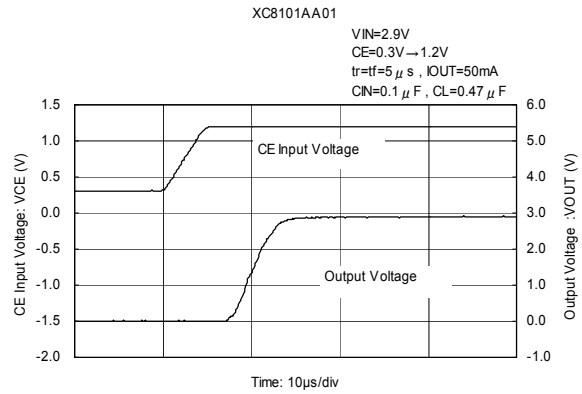
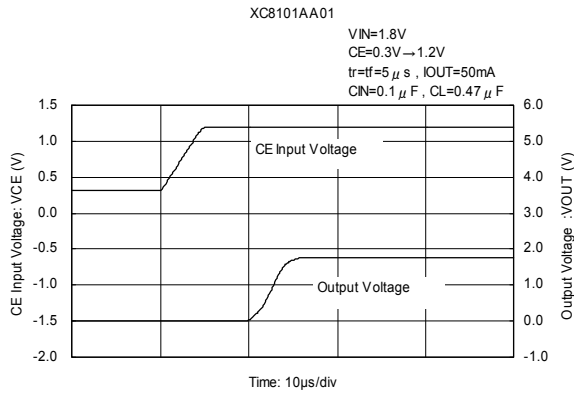
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



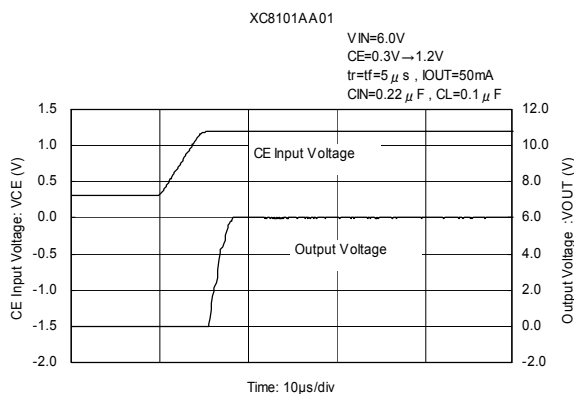
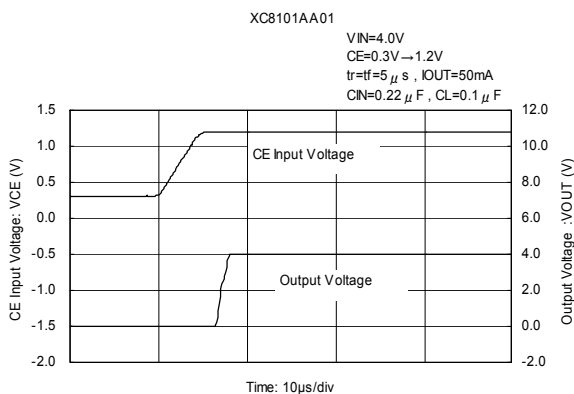
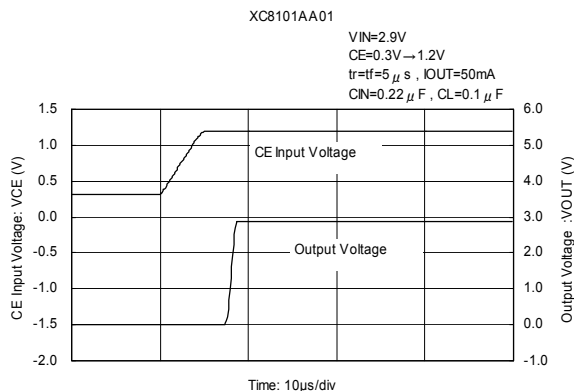
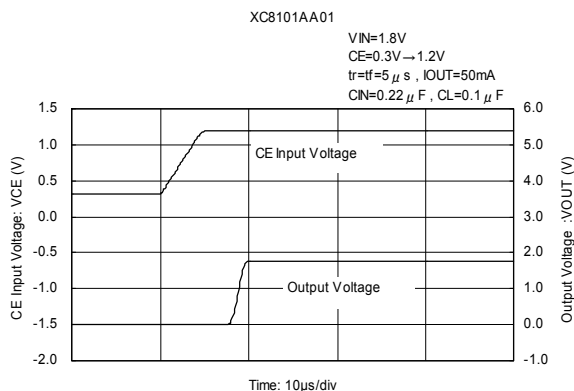
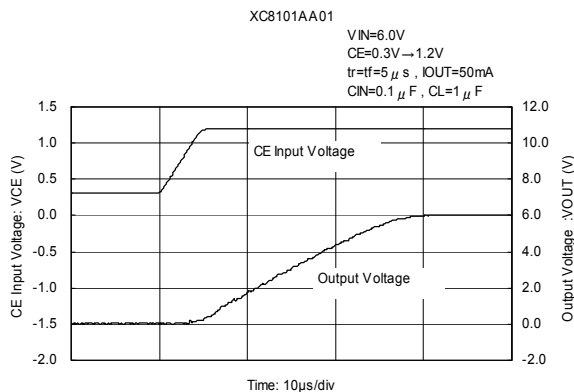
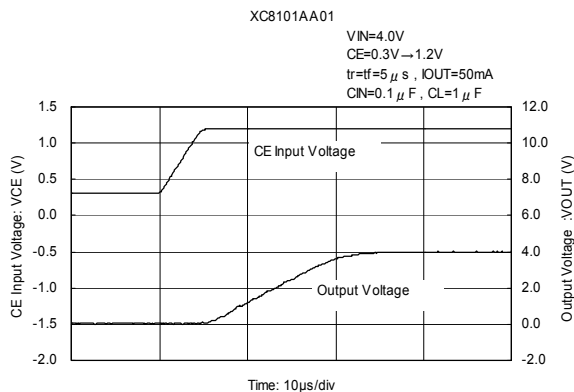
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



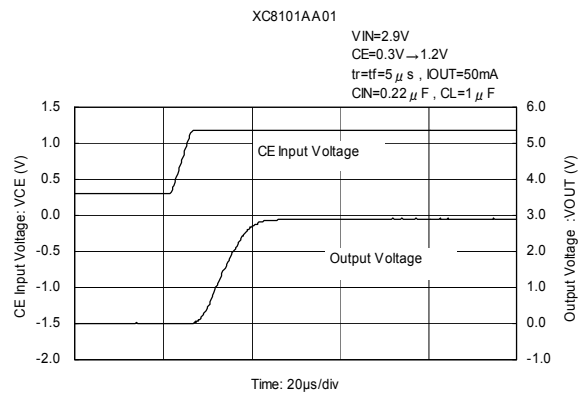
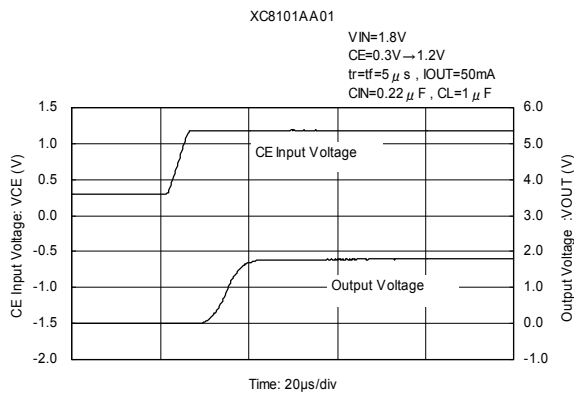
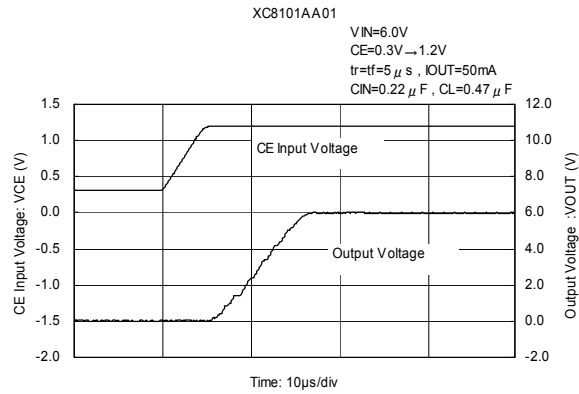
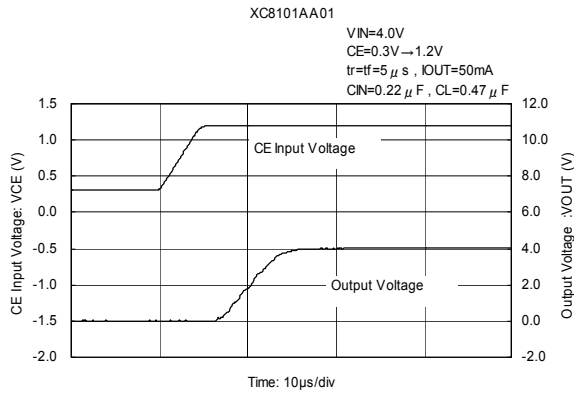
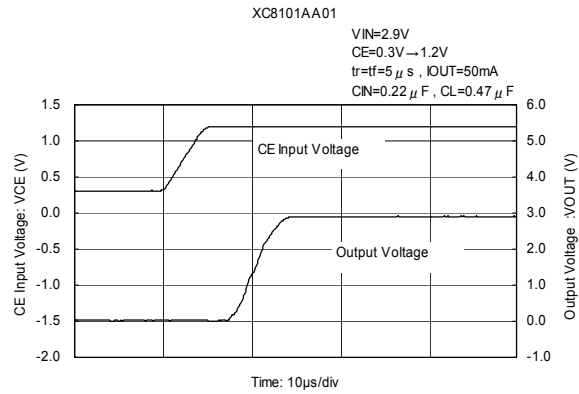
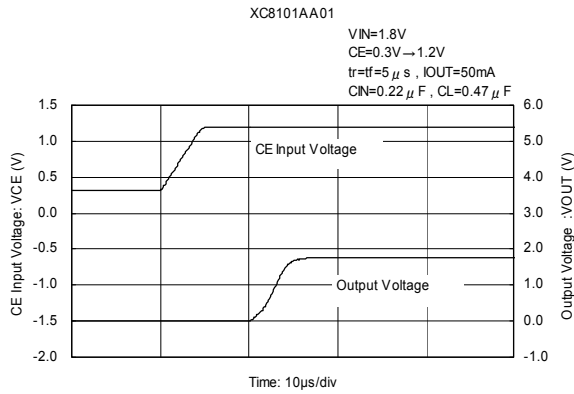
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



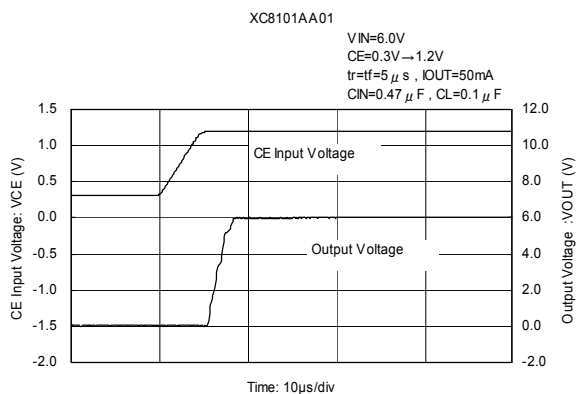
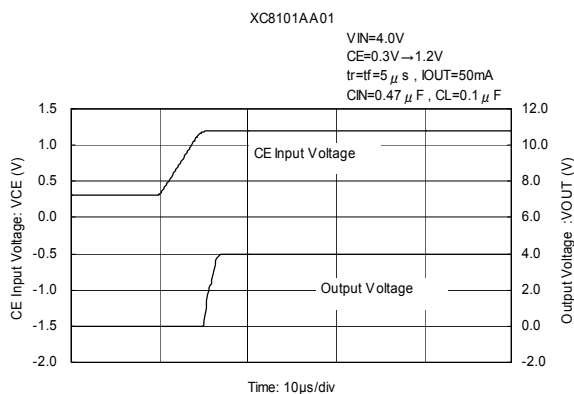
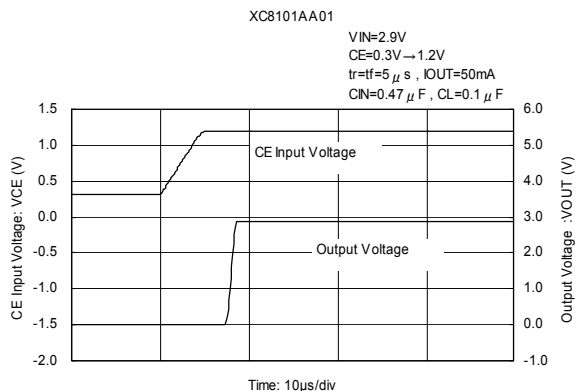
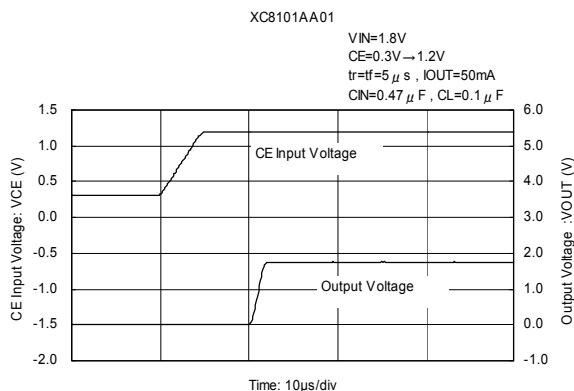
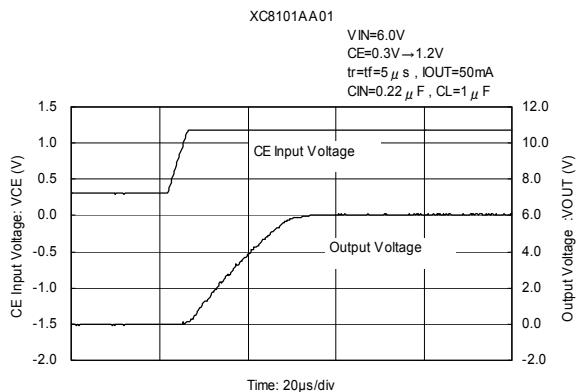
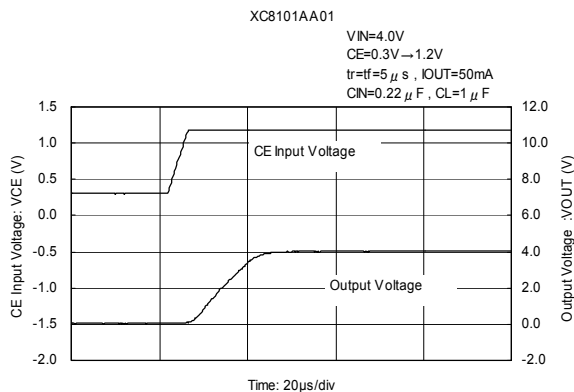
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



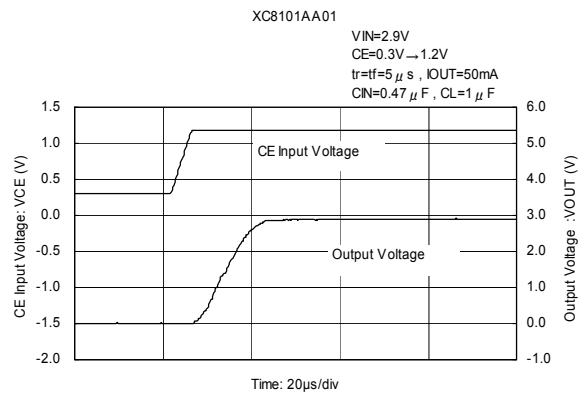
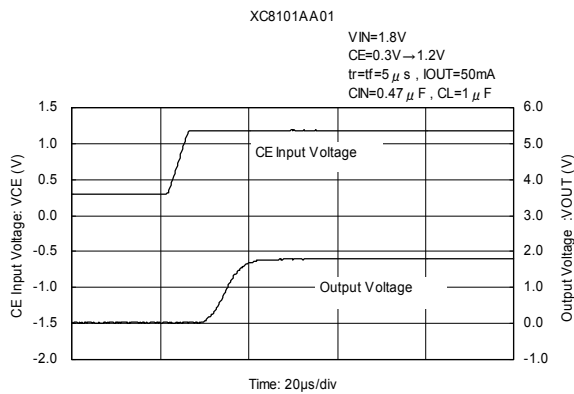
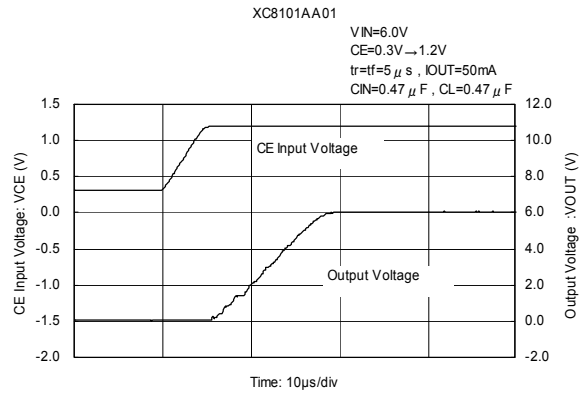
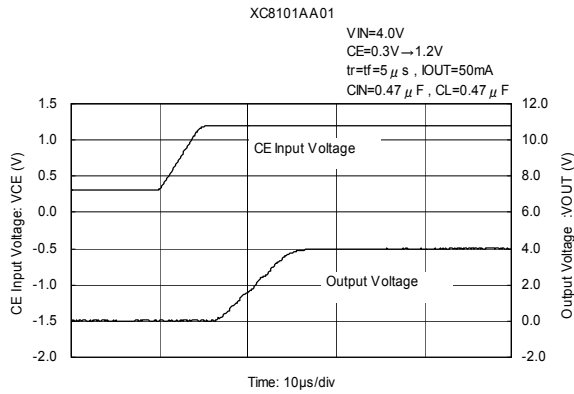
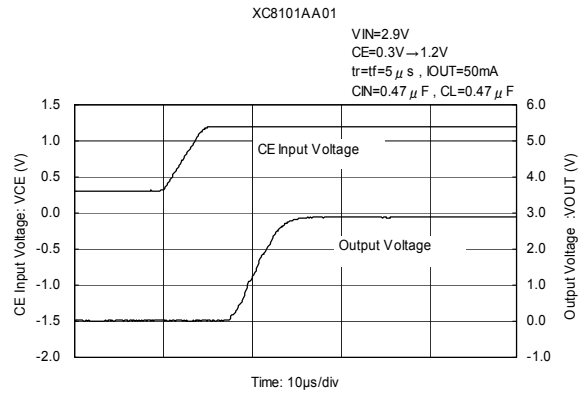
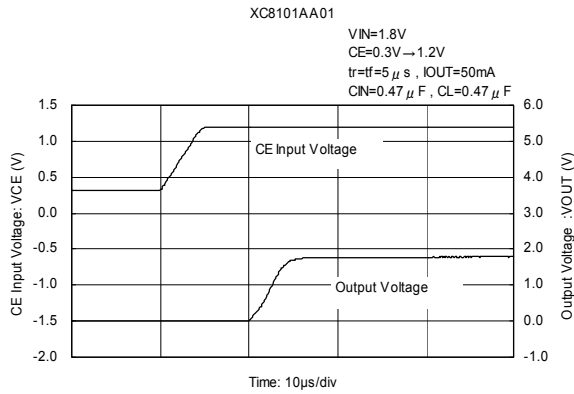
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



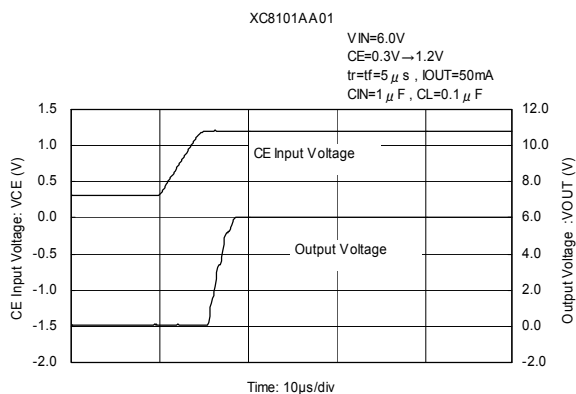
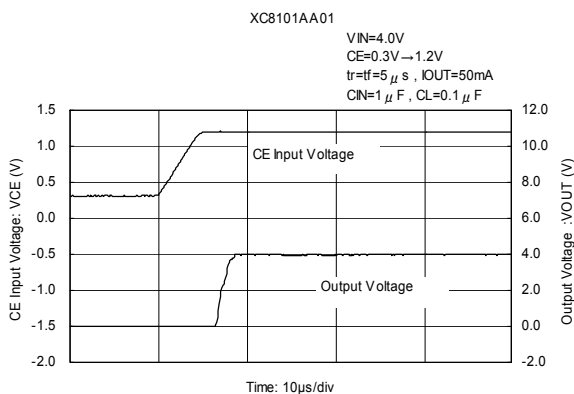
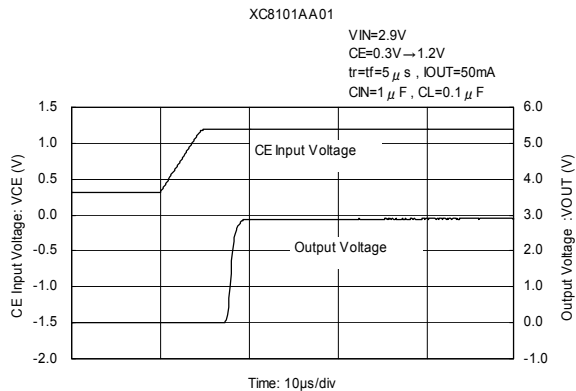
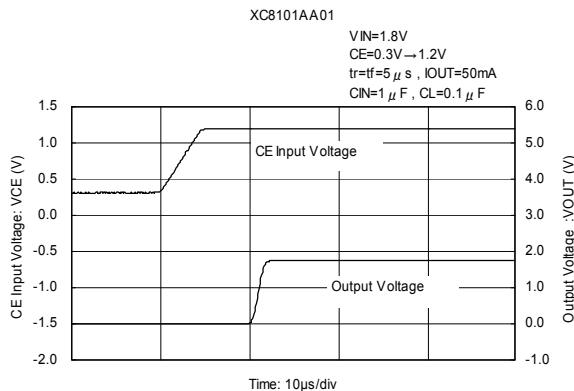
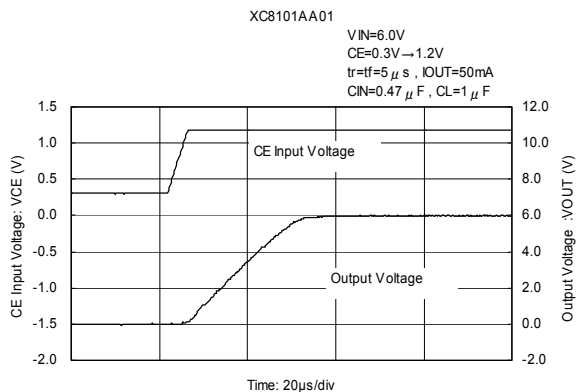
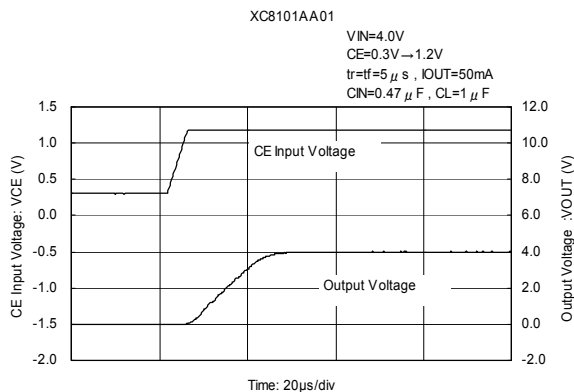
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



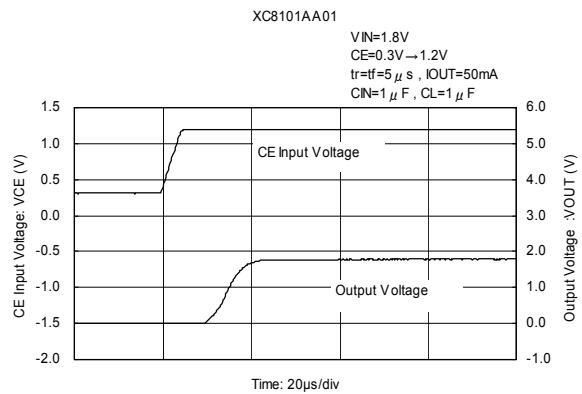
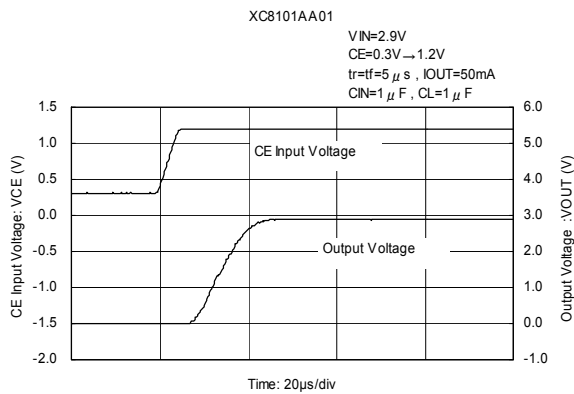
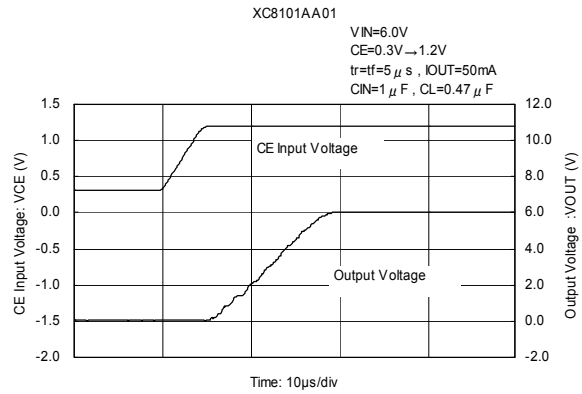
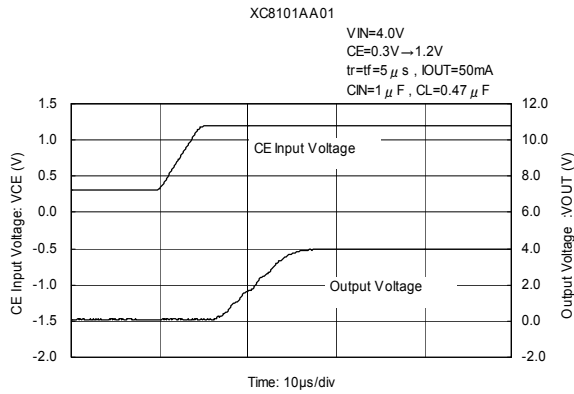
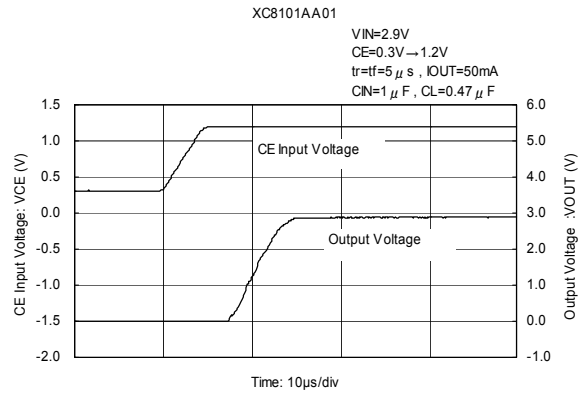
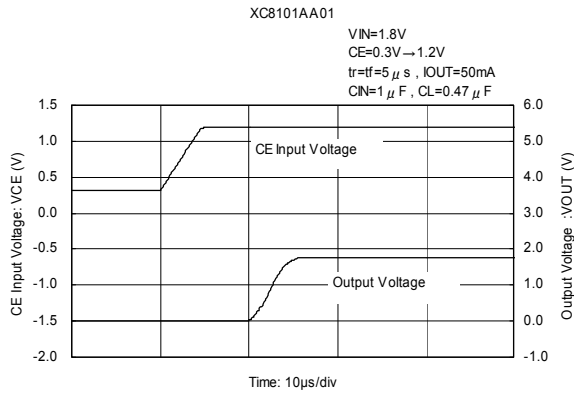
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)



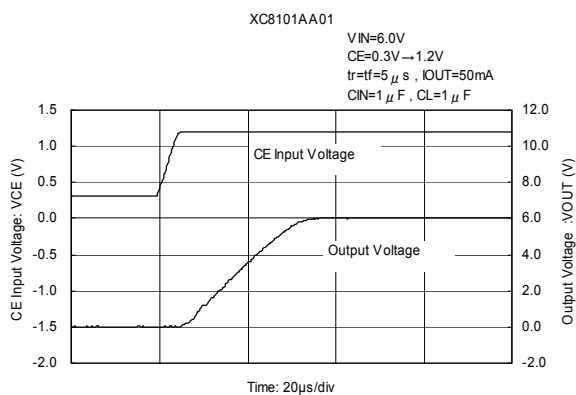
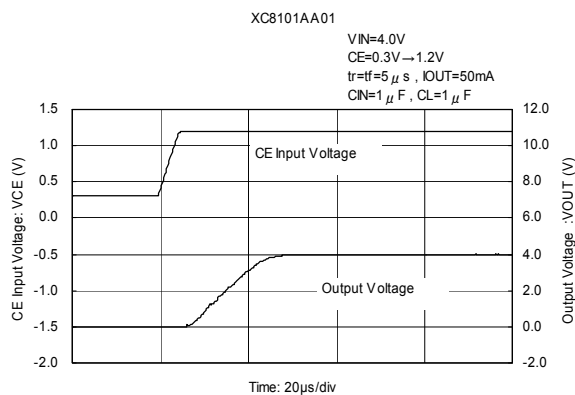
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)

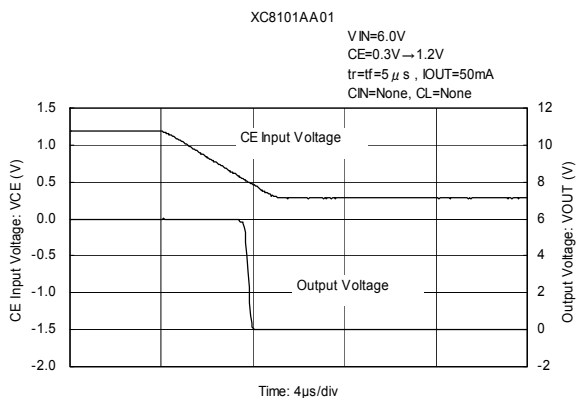
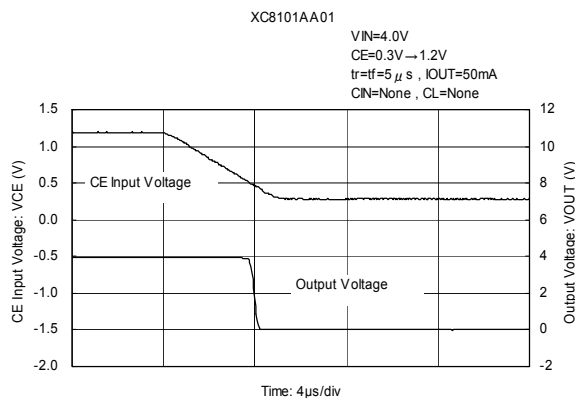
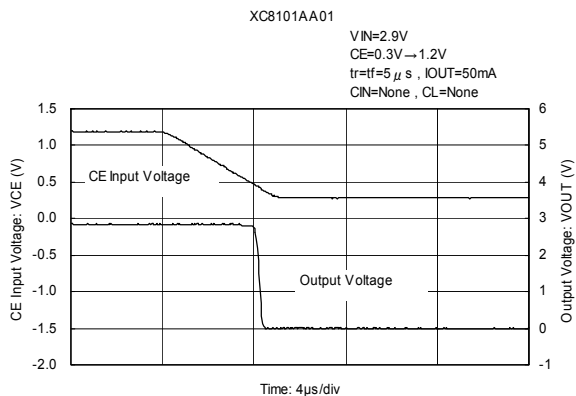
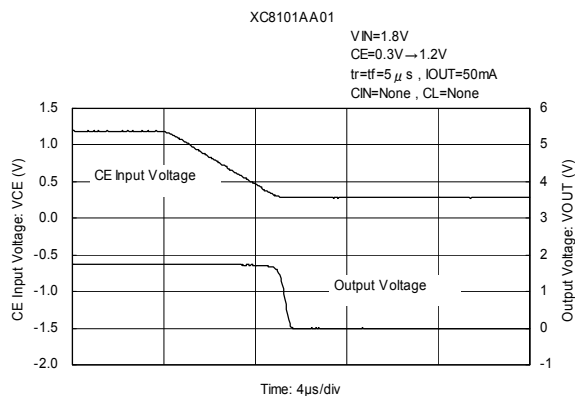


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)

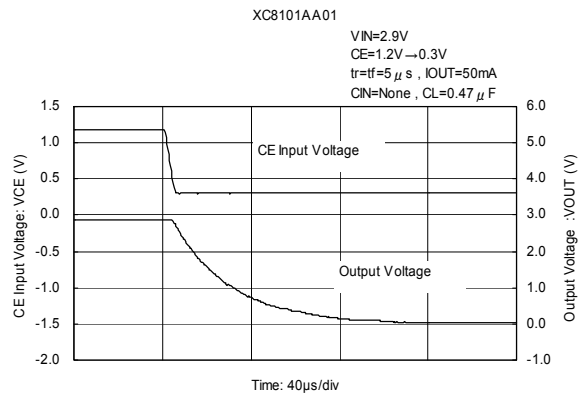
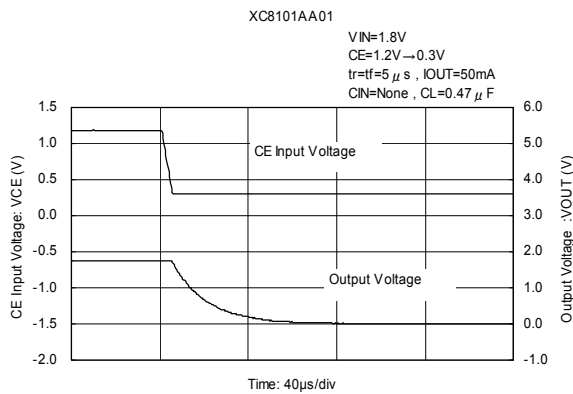
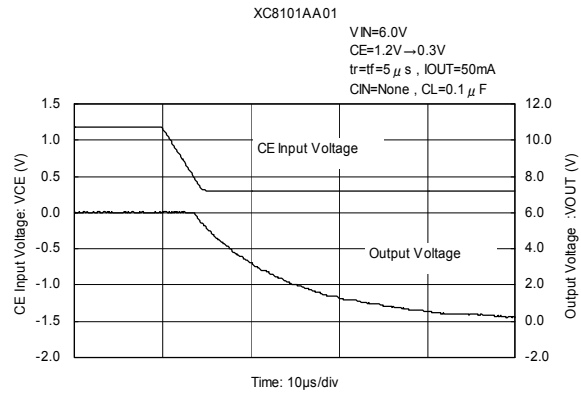
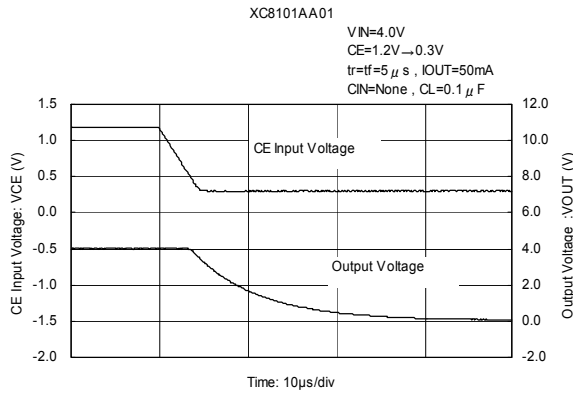
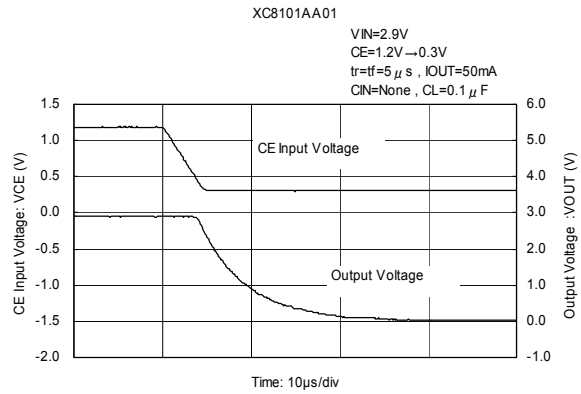
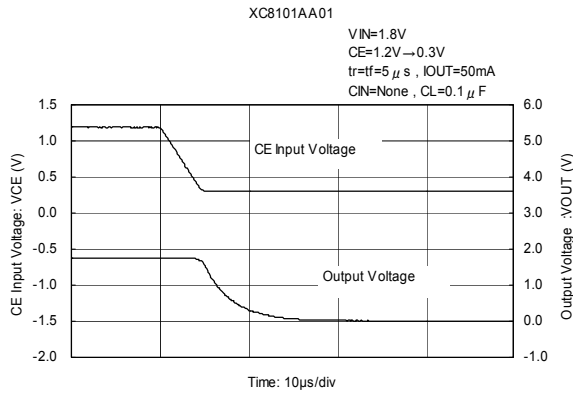


(9) Output Turn-off Time with CE



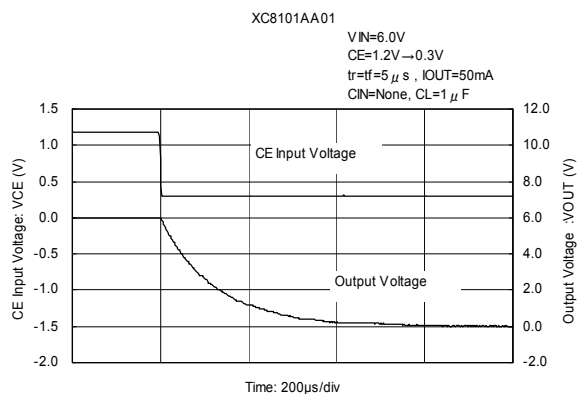
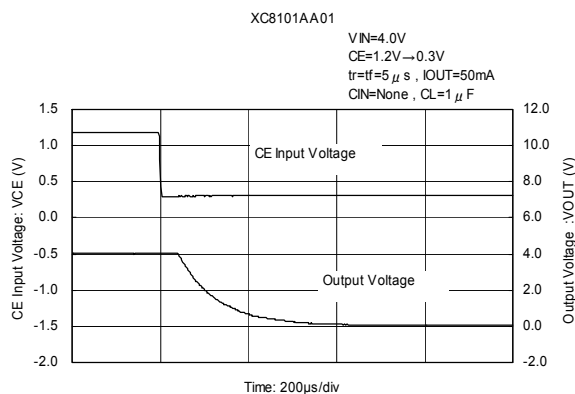
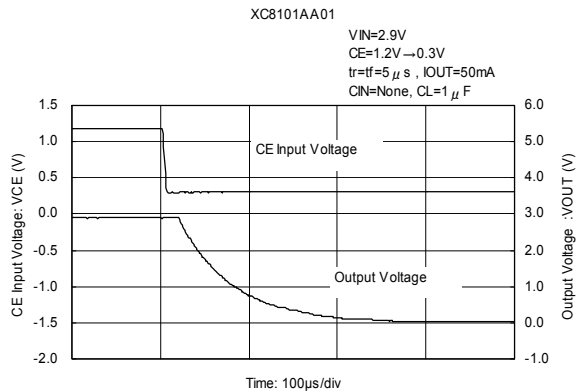
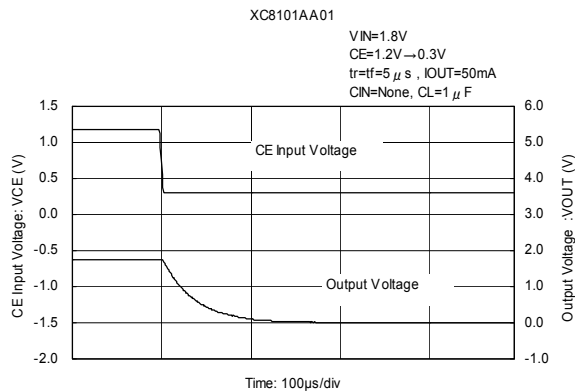
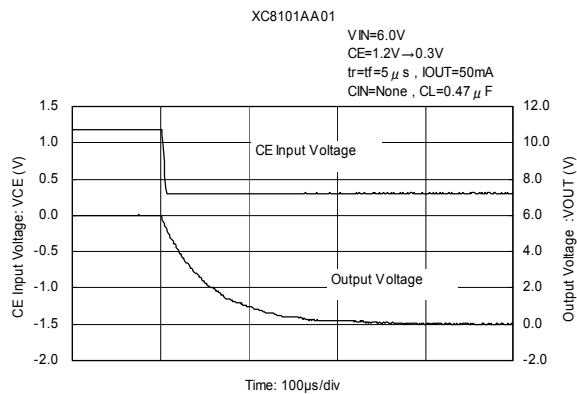
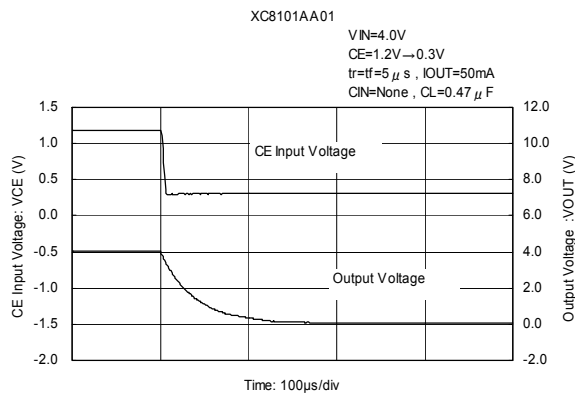
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



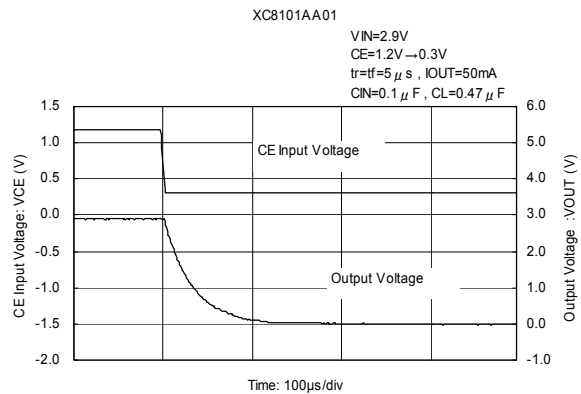
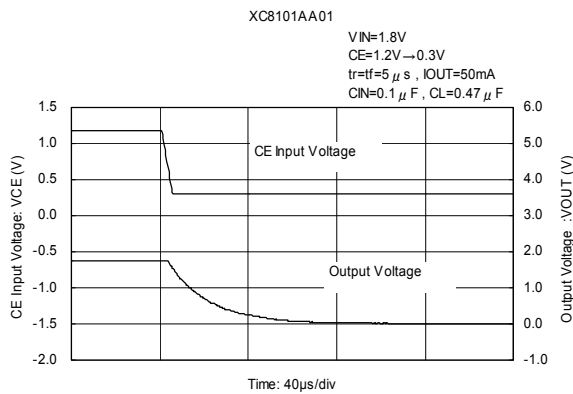
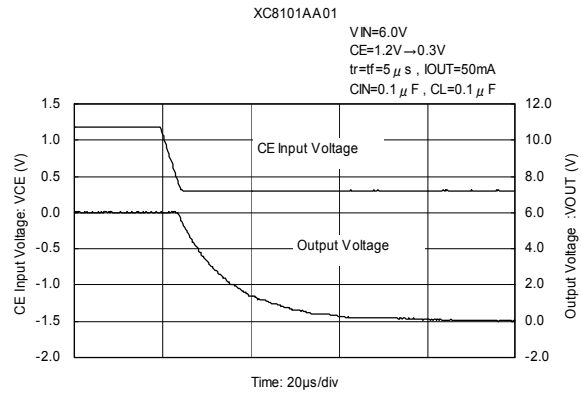
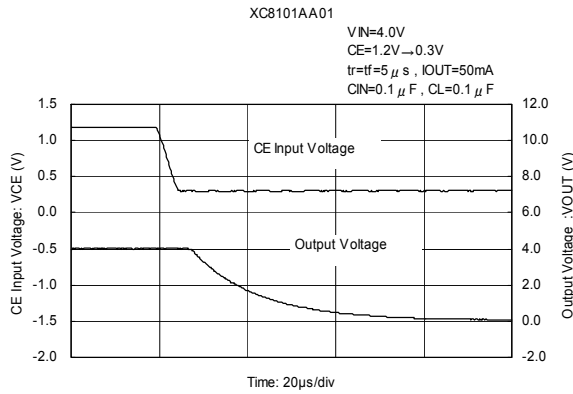
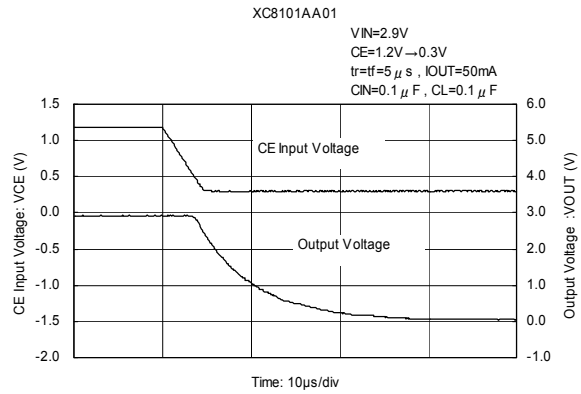
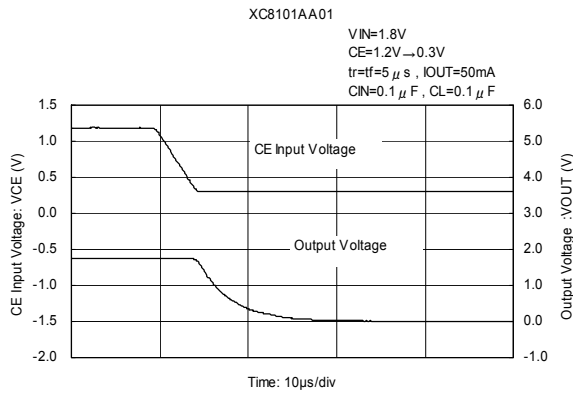
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



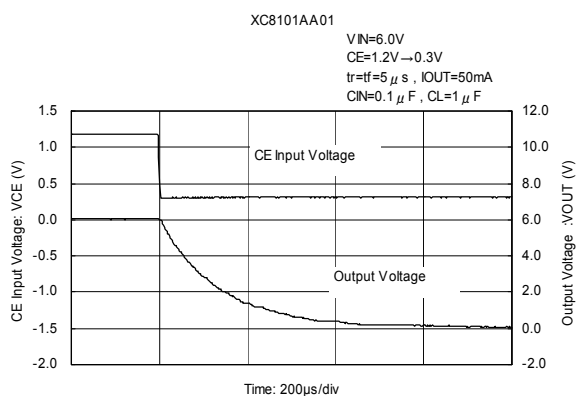
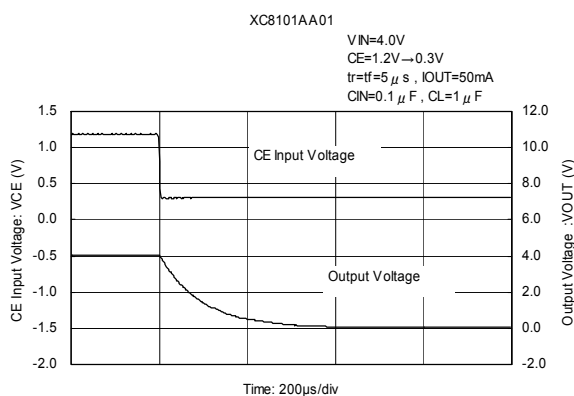
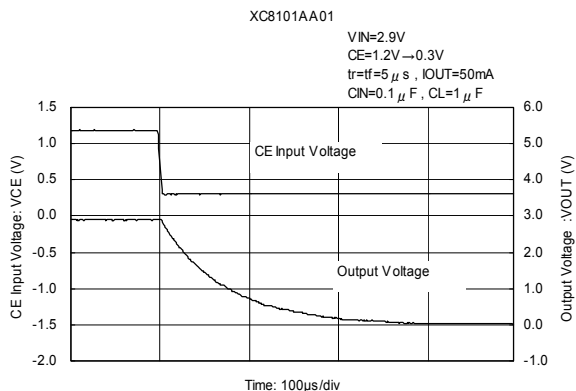
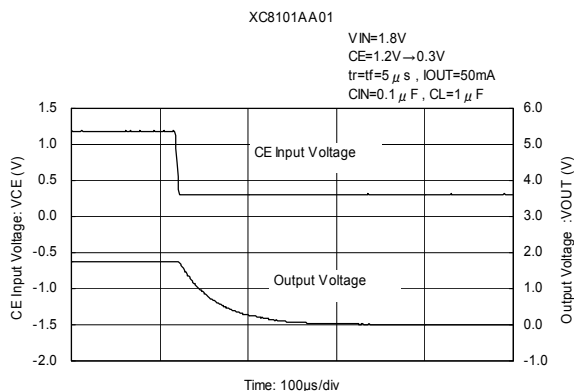
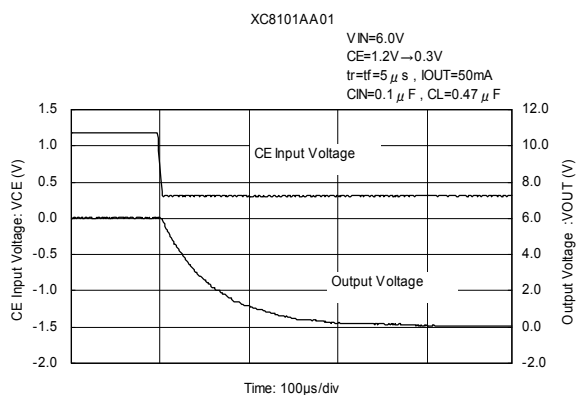
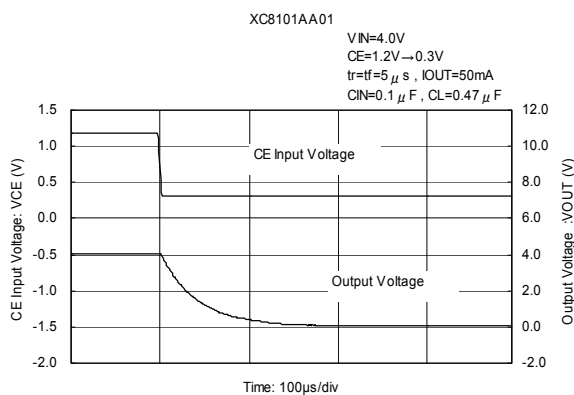
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



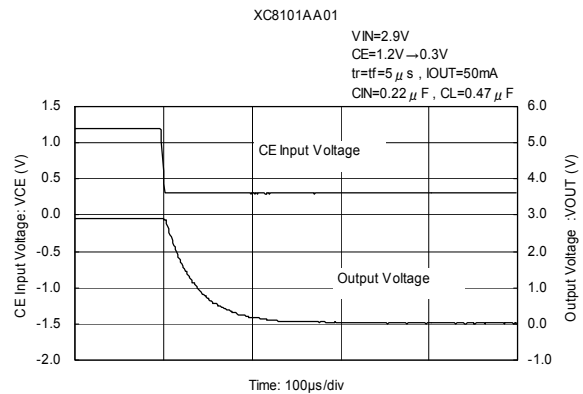
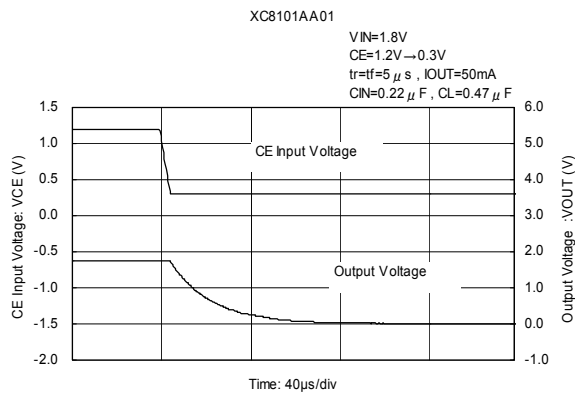
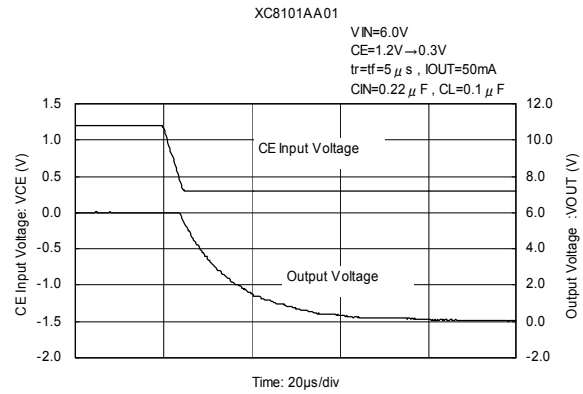
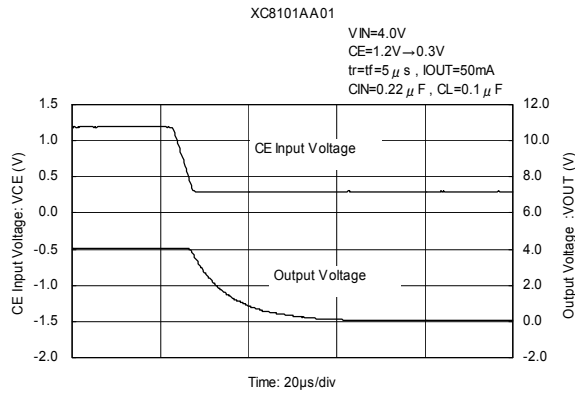
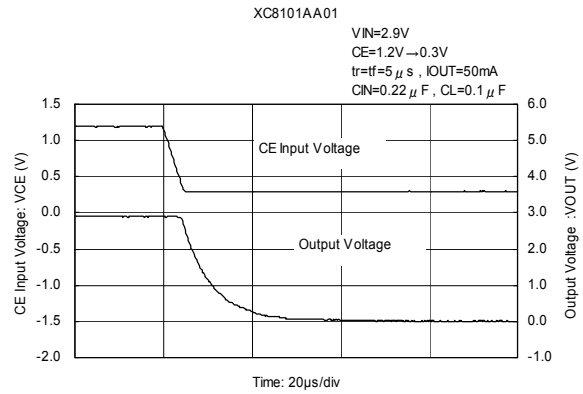
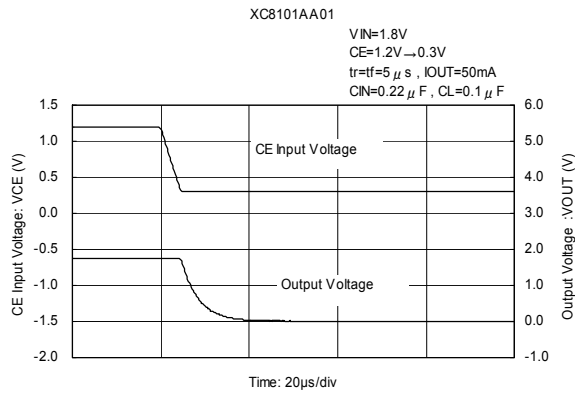
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



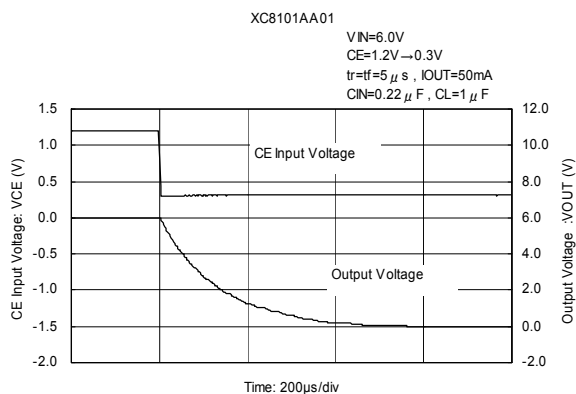
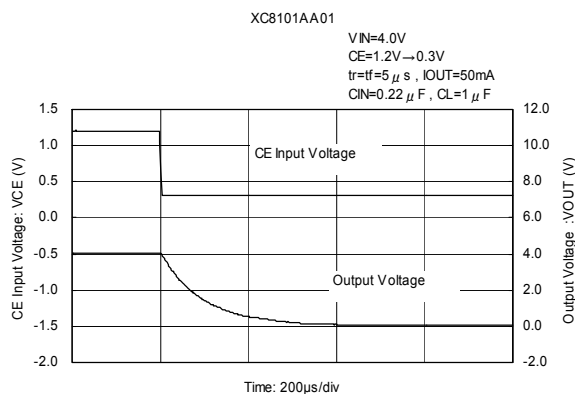
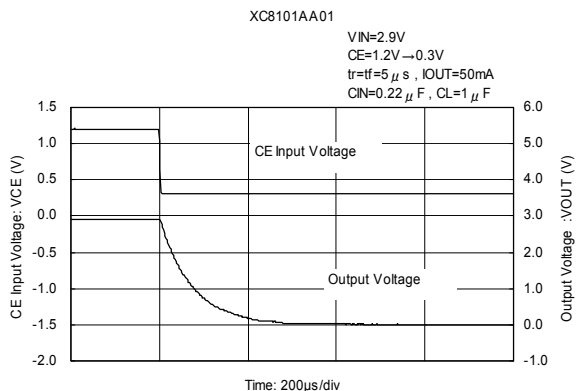
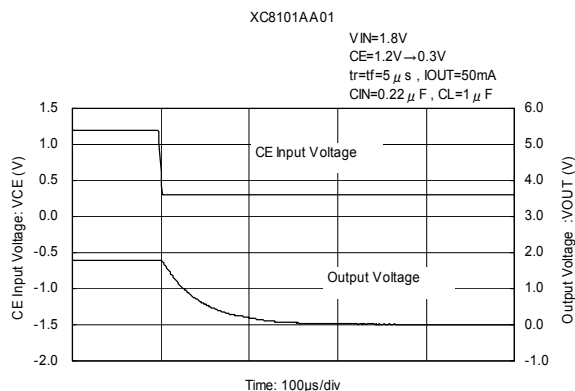
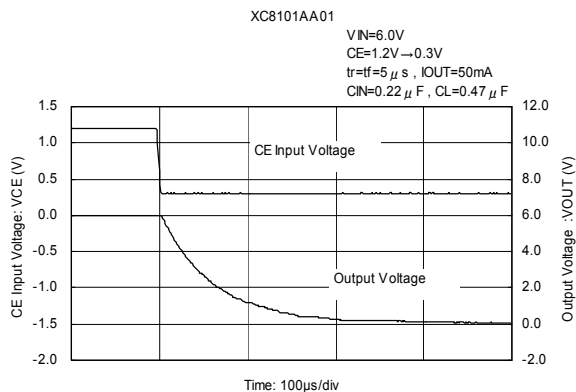
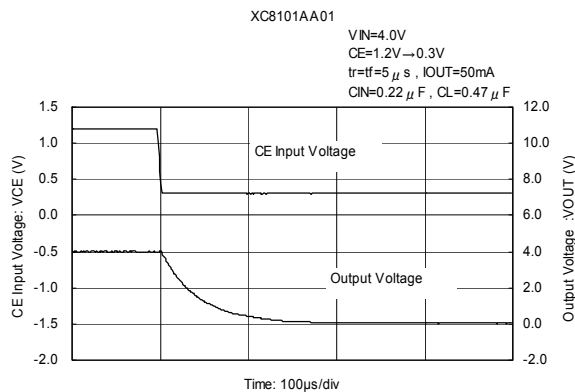
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



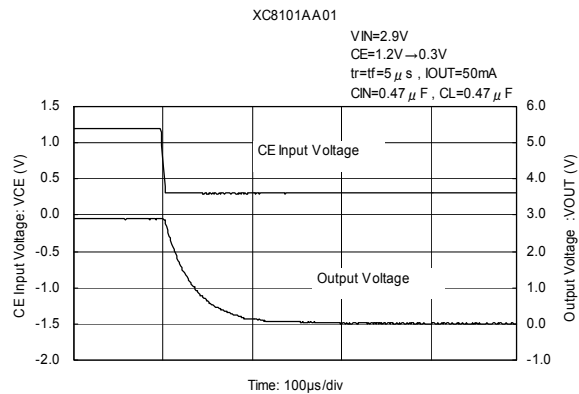
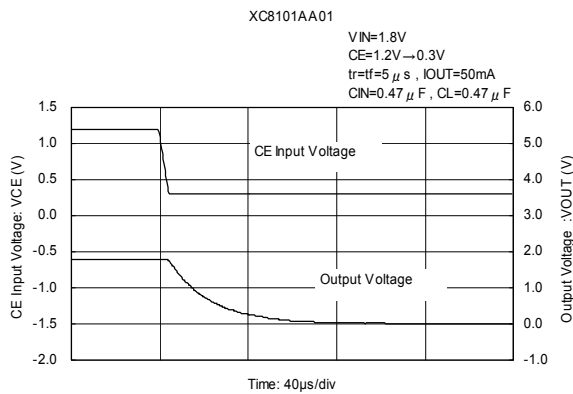
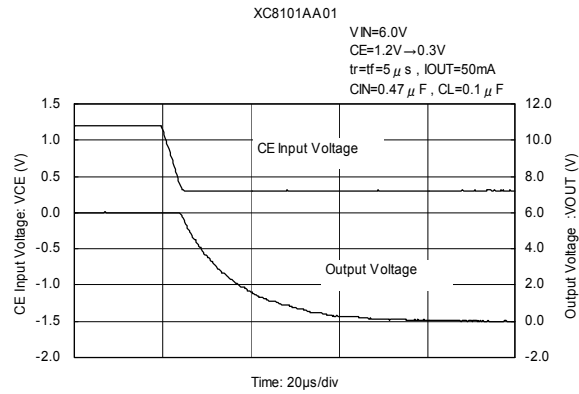
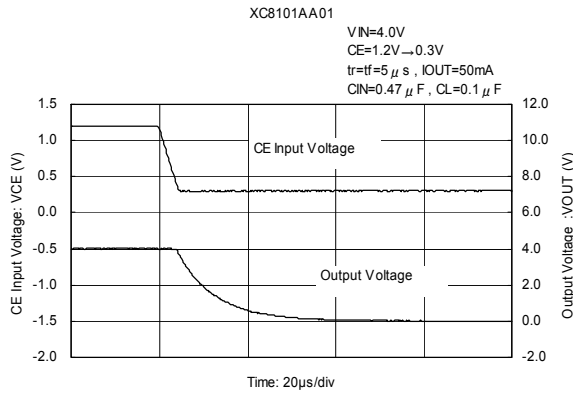
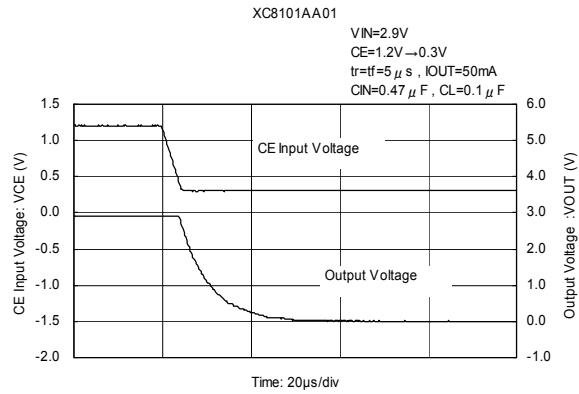
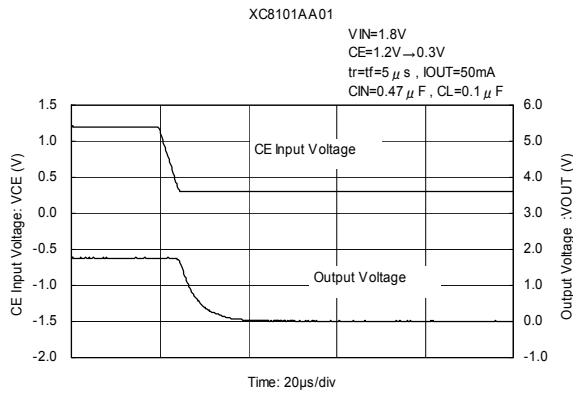
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



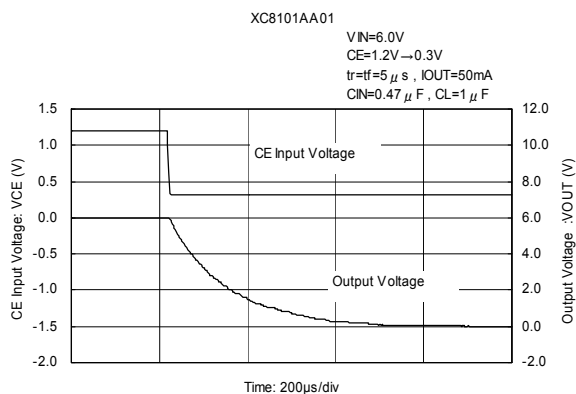
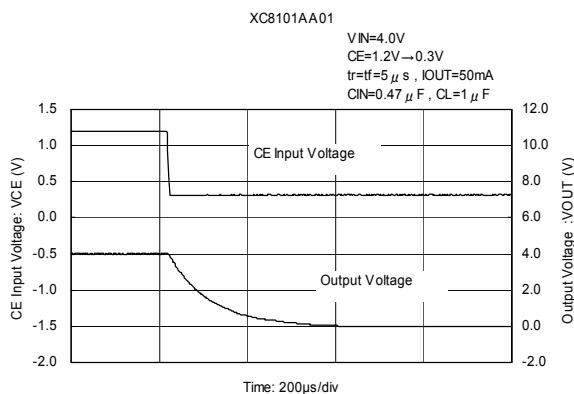
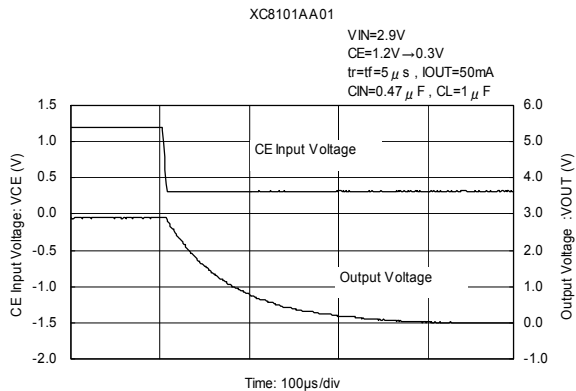
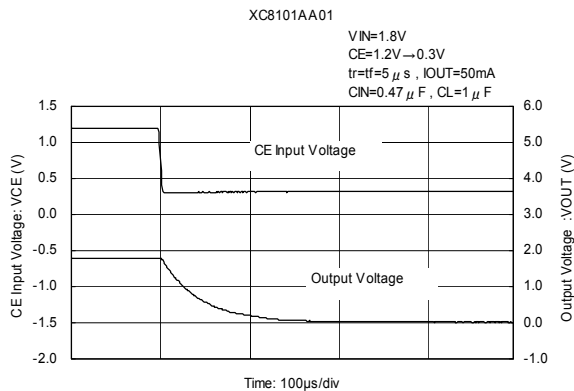
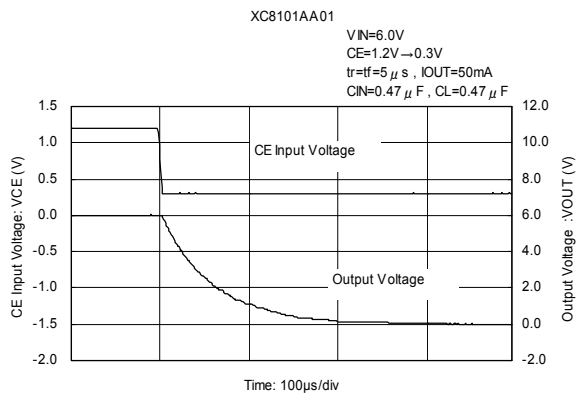
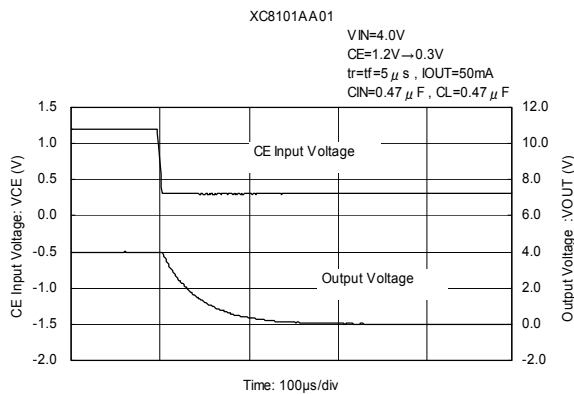
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



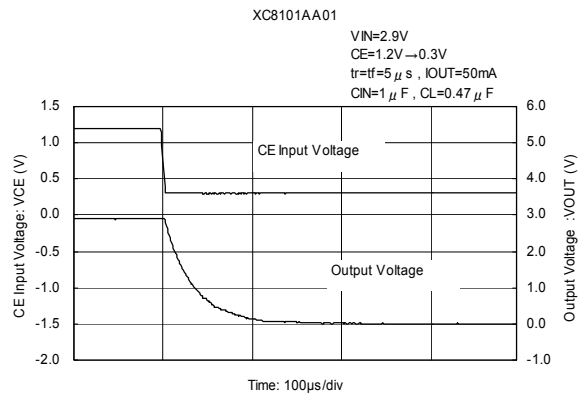
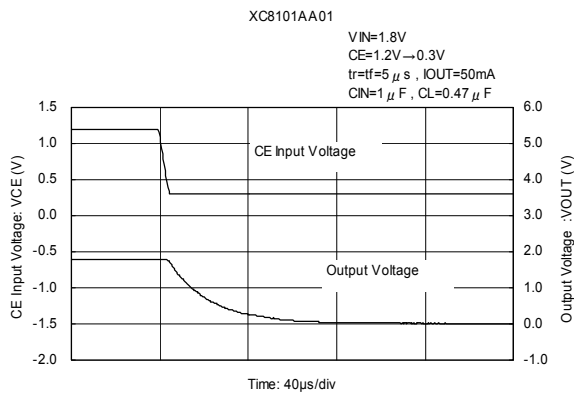
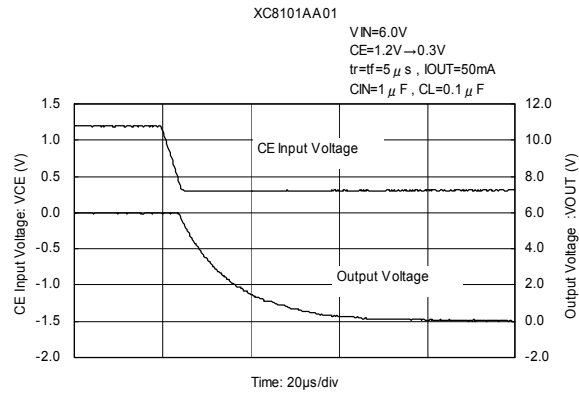
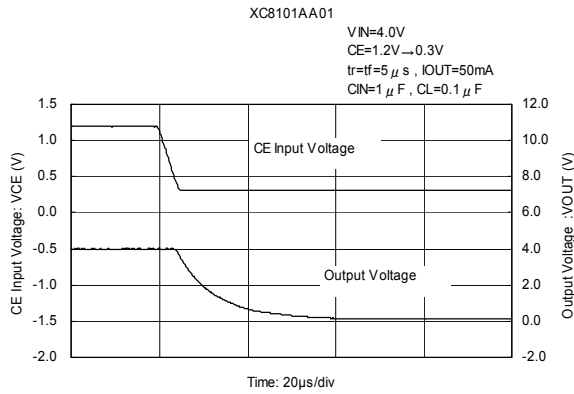
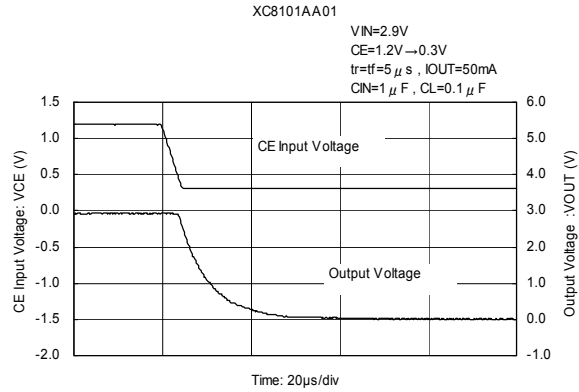
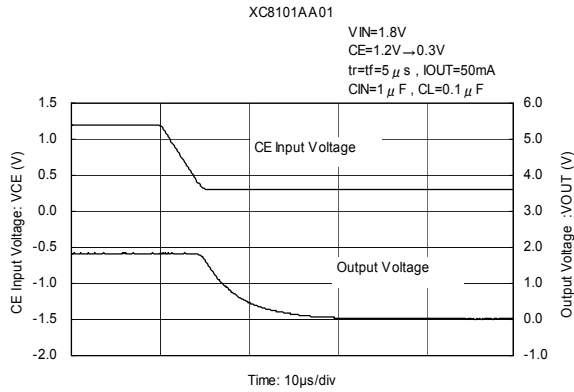
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



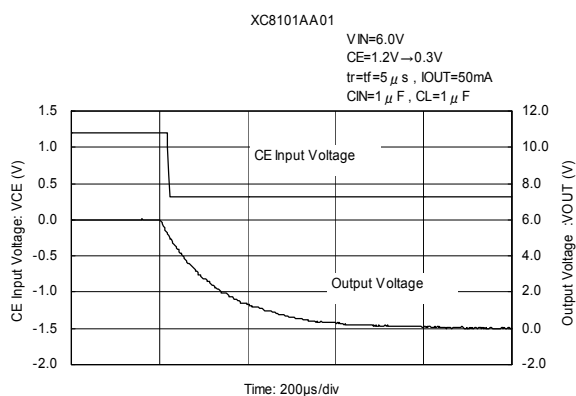
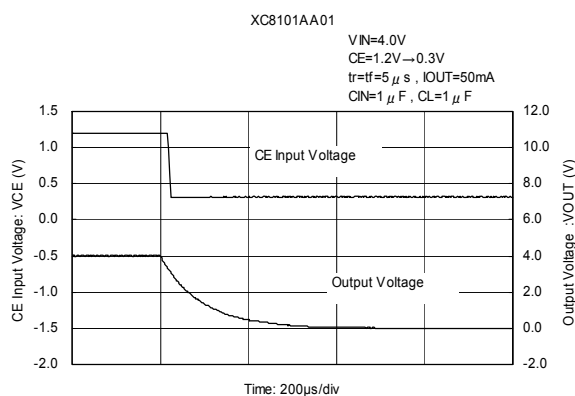
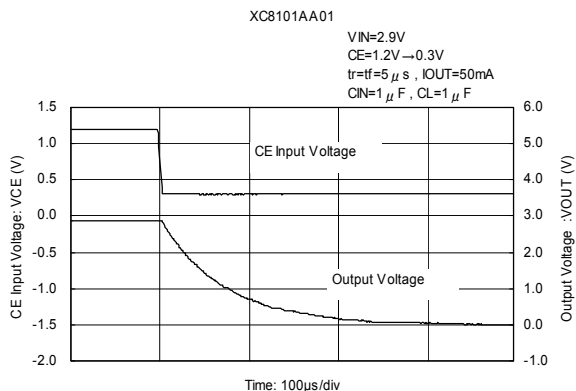
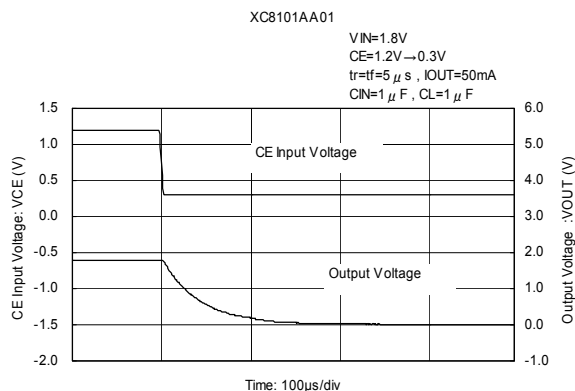
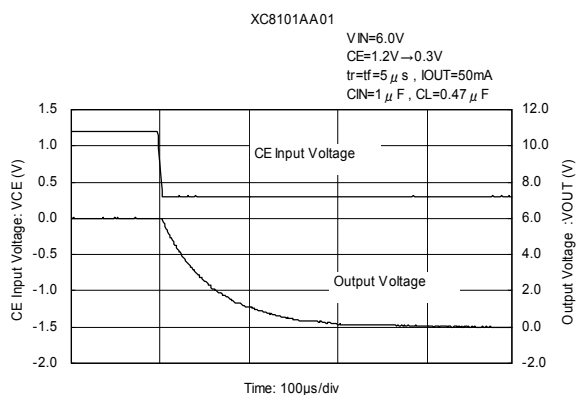
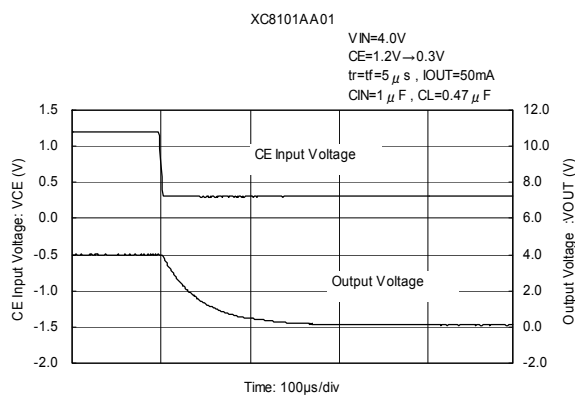
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



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